Kinetis V Series Peripheral Module
Quick Reference

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## Chapter 1
### General System Setup (Software Considerations)

<table>
<thead>
<tr>
<th>Section number</th>
<th>Title</th>
<th>Page</th>
</tr>
</thead>
<tbody>
<tr>
<td>1.1</td>
<td>Software considerations</td>
<td>9</td>
</tr>
<tr>
<td>1.1.1</td>
<td>Overview</td>
<td>9</td>
</tr>
<tr>
<td>1.1.2</td>
<td>Code execution</td>
<td>9</td>
</tr>
<tr>
<td>1.1.3</td>
<td>Reset and booting</td>
<td>9</td>
</tr>
<tr>
<td>1.1.3.1</td>
<td>Device state during reset</td>
<td>10</td>
</tr>
<tr>
<td>1.1.3.2</td>
<td>Device state after reset</td>
<td>10</td>
</tr>
<tr>
<td>1.1.4</td>
<td>Typical system initialization</td>
<td>10</td>
</tr>
<tr>
<td>1.1.4.1</td>
<td>Lowest level assembly routines</td>
<td>10</td>
</tr>
<tr>
<td>1.1.4.1.1</td>
<td>Initialize general purpose registers</td>
<td>10</td>
</tr>
<tr>
<td>1.1.4.1.1.1</td>
<td>Unmask interrupts at ARM® core</td>
<td>11</td>
</tr>
<tr>
<td>1.1.4.1.1.2</td>
<td>Branch to start of C initialization code</td>
<td>11</td>
</tr>
<tr>
<td>1.1.4.2</td>
<td>Startup routines</td>
<td>11</td>
</tr>
<tr>
<td>1.1.4.2.1</td>
<td>Disable watchdog</td>
<td>11</td>
</tr>
<tr>
<td>1.1.4.2.2</td>
<td>Initialize RAM</td>
<td>11</td>
</tr>
<tr>
<td>1.1.4.2.3</td>
<td>Enable port clocks</td>
<td>11</td>
</tr>
<tr>
<td>1.1.4.2.4</td>
<td>Ramp system clock to selected frequency</td>
<td>12</td>
</tr>
<tr>
<td>1.1.4.2.5</td>
<td>Enable UART for terminal communication</td>
<td>12</td>
</tr>
<tr>
<td>1.1.4.2.6</td>
<td>Jump to start of main function for application</td>
<td>12</td>
</tr>
</tbody>
</table>

## Chapter 2
### General System Setup (Hardware Considerations)

<table>
<thead>
<tr>
<th>Section number</th>
<th>Title</th>
<th>Page</th>
</tr>
</thead>
<tbody>
<tr>
<td>2.1</td>
<td>Hardware considerations</td>
<td>13</td>
</tr>
<tr>
<td>2.1.1</td>
<td>Overview</td>
<td>13</td>
</tr>
<tr>
<td>2.1.2</td>
<td>Floorplan</td>
<td>13</td>
</tr>
<tr>
<td>2.1.2.1</td>
<td>Connectors</td>
<td>14</td>
</tr>
<tr>
<td>2.1.3</td>
<td>PCB routing considerations</td>
<td>14</td>
</tr>
<tr>
<td>2.1.3.1</td>
<td>Power supply routing</td>
<td>14</td>
</tr>
<tr>
<td>Section number</td>
<td>Title</td>
<td>Page</td>
</tr>
<tr>
<td>----------------</td>
<td>----------------------------------------------------------------------</td>
<td>------</td>
</tr>
<tr>
<td>2.1.3.2</td>
<td>Power supply decoupling and filtering</td>
<td>15</td>
</tr>
<tr>
<td>2.1.3.3</td>
<td>Oscillators</td>
<td>15</td>
</tr>
<tr>
<td>2.1.3.3.1</td>
<td>MCG oscillator</td>
<td>15</td>
</tr>
<tr>
<td>2.1.3.4</td>
<td>General filtering</td>
<td>18</td>
</tr>
<tr>
<td>2.1.3.4.1</td>
<td>RESET_b and NMI_b</td>
<td>18</td>
</tr>
<tr>
<td>2.1.3.4.2</td>
<td>General purpose I/O</td>
<td>19</td>
</tr>
<tr>
<td>2.1.3.4.3</td>
<td>Analog inputs</td>
<td>19</td>
</tr>
<tr>
<td>2.1.4</td>
<td>PCB layer stack-up</td>
<td>19</td>
</tr>
<tr>
<td>2.1.5</td>
<td>Other module hardware considerations</td>
<td>22</td>
</tr>
<tr>
<td>2.1.5.1</td>
<td>Debug interface</td>
<td>22</td>
</tr>
</tbody>
</table>

Chapter 3

Nested Vector Interrupt Controller (NVIC)

3.1 NVIC

3.1.1 Overview

3.1.1.1 Introduction

3.1.1.2 Features

3.1.2 Configuration examples

3.1.2.1 Configuring the NVIC

3.1.2.1.1 Code example and explanation

3.1.2.2 Relocating the vector table

3.1.2.2.1 Code example and explanation

Chapter 4

Clocking System

4.1 Clocking

4.1.1 Overview

4.1.2 Features

4.1.3 Configuration examples

4.1.4 Clocking system device hardware implementation

4.1.5 Layout guidelines for general routing and placement
### Chapter 5

**Power Management Control (PMC/SMC/LLWU/RCM)**

<table>
<thead>
<tr>
<th>Section number</th>
<th>Title</th>
<th>Page</th>
</tr>
</thead>
<tbody>
<tr>
<td>4.1.6</td>
<td>References</td>
<td>34</td>
</tr>
<tr>
<td>5.1</td>
<td>Introduction</td>
<td>37</td>
</tr>
<tr>
<td>5.2</td>
<td>Using the power management controller</td>
<td>37</td>
</tr>
<tr>
<td>5.2.1</td>
<td>Overview</td>
<td>37</td>
</tr>
<tr>
<td>5.2.2</td>
<td>Using the low voltage detection system</td>
<td>37</td>
</tr>
<tr>
<td>5.2.2.1</td>
<td>POR and LVD features</td>
<td>37</td>
</tr>
<tr>
<td>5.2.2.2</td>
<td>Configuration examples</td>
<td>38</td>
</tr>
<tr>
<td>5.2.2.3</td>
<td>Interrupt code example and explanation</td>
<td>39</td>
</tr>
<tr>
<td>5.2.2.4</td>
<td>Hardware implementation</td>
<td>40</td>
</tr>
<tr>
<td>5.3</td>
<td>Using the system mode controller</td>
<td>42</td>
</tr>
<tr>
<td>5.3.1</td>
<td>Overview</td>
<td>42</td>
</tr>
<tr>
<td>5.3.1.1</td>
<td>Introduction</td>
<td>42</td>
</tr>
<tr>
<td>5.3.1.2</td>
<td>Entering and exiting power modes</td>
<td>43</td>
</tr>
<tr>
<td>5.3.2</td>
<td>Configuration examples</td>
<td>43</td>
</tr>
<tr>
<td>5.3.2.1</td>
<td>SMC code example and explanation</td>
<td>44</td>
</tr>
<tr>
<td>5.3.2.2</td>
<td>Entering wait mode</td>
<td>45</td>
</tr>
<tr>
<td>5.3.2.3</td>
<td>Exiting low-power modes</td>
<td>45</td>
</tr>
<tr>
<td>5.4</td>
<td>Using the low leakage wakeup unit</td>
<td>46</td>
</tr>
<tr>
<td>5.4.1</td>
<td>Overview</td>
<td>46</td>
</tr>
<tr>
<td>5.4.1.1</td>
<td>Mode transitions</td>
<td>46</td>
</tr>
<tr>
<td>5.4.1.2</td>
<td>Wake-up sources</td>
<td>46</td>
</tr>
<tr>
<td>5.4.2</td>
<td>LLWU configuration examples</td>
<td>47</td>
</tr>
<tr>
<td>5.4.2.1</td>
<td>Enabling pins and modules in the LLWU</td>
<td>47</td>
</tr>
<tr>
<td>5.4.2.2</td>
<td>Module wake-up</td>
<td>47</td>
</tr>
<tr>
<td>5.4.2.3</td>
<td>Pin wake-up</td>
<td>47</td>
</tr>
<tr>
<td>5.4.2.4</td>
<td>LLWU port and module interrupts</td>
<td>48</td>
</tr>
<tr>
<td>Section number</td>
<td>Title</td>
<td>Page</td>
</tr>
<tr>
<td>----------------</td>
<td>----------------------------------------------------</td>
<td>------</td>
</tr>
<tr>
<td>5.4.2.5</td>
<td>Wake-up sequence</td>
<td>48</td>
</tr>
<tr>
<td>5.5</td>
<td>Module operation in low-power modes</td>
<td>50</td>
</tr>
<tr>
<td>5.6</td>
<td>Mode transition requirements</td>
<td>52</td>
</tr>
<tr>
<td>5.7</td>
<td>Source of wake-up, pins, and modules</td>
<td>53</td>
</tr>
</tbody>
</table>

**Chapter 6**

*enhanced Direct Memory Access (eDMA) Controller*

<table>
<thead>
<tr>
<th>6.1</th>
<th>eDMA</th>
<th>55</th>
</tr>
</thead>
<tbody>
<tr>
<td>6.1.1</td>
<td>Overview</td>
<td>55</td>
</tr>
<tr>
<td>6.1.2</td>
<td>Introduction</td>
<td>55</td>
</tr>
<tr>
<td>6.2</td>
<td>eDMA trigger</td>
<td>57</td>
</tr>
<tr>
<td>6.2.1</td>
<td>DMA multiplexer</td>
<td>57</td>
</tr>
<tr>
<td>6.2.2</td>
<td>Trigger mode</td>
<td>58</td>
</tr>
<tr>
<td>6.2.3</td>
<td>Multiple transfer requests</td>
<td>58</td>
</tr>
<tr>
<td>6.3</td>
<td>Transfer process</td>
<td>59</td>
</tr>
<tr>
<td>6.4</td>
<td>Configuration steps</td>
<td>60</td>
</tr>
<tr>
<td>6.5</td>
<td>Example—ADC scan multiple channels</td>
<td>60</td>
</tr>
<tr>
<td>6.5.1</td>
<td>Module configuration</td>
<td>61</td>
</tr>
</tbody>
</table>

**Chapter 7**

*Universal Asynchronous Receiver and Transmitter (UART) Module*

<table>
<thead>
<tr>
<th>7.1</th>
<th>Overview</th>
<th>63</th>
</tr>
</thead>
<tbody>
<tr>
<td>7.2</td>
<td>Features</td>
<td>63</td>
</tr>
<tr>
<td>7.3</td>
<td>Configuration example</td>
<td>64</td>
</tr>
<tr>
<td>7.3.1</td>
<td>UART initialization example</td>
<td>65</td>
</tr>
<tr>
<td>7.3.2</td>
<td>UART receive example</td>
<td>66</td>
</tr>
<tr>
<td>7.3.3</td>
<td>UART transmit example</td>
<td>67</td>
</tr>
<tr>
<td>7.3.4</td>
<td>UART configuration for interrupts or DMA requests</td>
<td>67</td>
</tr>
<tr>
<td>7.4</td>
<td>UART RS-232 hardware implementation</td>
<td>68</td>
</tr>
</tbody>
</table>

**Chapter 8**

*Memory-Mapped Divide and Square Root (MMDVSQ)*

<p>| 8.1            | Introduction                                       | 69   |</p>
<table>
<thead>
<tr>
<th>Section number</th>
<th>Title</th>
<th>Page</th>
</tr>
</thead>
<tbody>
<tr>
<td>8.2</td>
<td>Features</td>
<td>69</td>
</tr>
<tr>
<td>8.3</td>
<td>MMDVSQ in Cortex-M0+ core platform</td>
<td>70</td>
</tr>
<tr>
<td>8.4</td>
<td>MMDVSQ programming model</td>
<td>70</td>
</tr>
<tr>
<td>8.5</td>
<td>Square root using Q notation for fractional data</td>
<td>72</td>
</tr>
<tr>
<td>8.6</td>
<td>Execution time</td>
<td>72</td>
</tr>
<tr>
<td>8.7</td>
<td>Tips of usage</td>
<td>73</td>
</tr>
<tr>
<td>8.7.1</td>
<td>Tips for minimizing the interrupt latency</td>
<td>73</td>
</tr>
<tr>
<td>8.7.2</td>
<td>Tips for context save and restore in interrupt</td>
<td>73</td>
</tr>
<tr>
<td>9</td>
<td>Chapter 9: Analog-to-Digital Converter (ADC)</td>
<td></td>
</tr>
<tr>
<td>9.1</td>
<td>Overview</td>
<td>75</td>
</tr>
<tr>
<td>9.2</td>
<td>Introduction</td>
<td>75</td>
</tr>
<tr>
<td>9.3</td>
<td>Features</td>
<td>76</td>
</tr>
<tr>
<td>9.4</td>
<td>ADC configuration</td>
<td>76</td>
</tr>
<tr>
<td>9.5</td>
<td>ADC hardware design considerations</td>
<td>77</td>
</tr>
<tr>
<td>10</td>
<td>Chapter 10: Programmable Delay Block (PDB)</td>
<td></td>
</tr>
<tr>
<td>10.1</td>
<td>Overview</td>
<td>79</td>
</tr>
<tr>
<td>10.2</td>
<td>Introduction</td>
<td>79</td>
</tr>
<tr>
<td>10.3</td>
<td>Features</td>
<td>80</td>
</tr>
<tr>
<td>10.4</td>
<td>PDB pre-trigger</td>
<td>80</td>
</tr>
<tr>
<td>10.5</td>
<td>Ping-Pong operation</td>
<td>82</td>
</tr>
<tr>
<td>10.5.1</td>
<td>PDB pre-trigger sample mode</td>
<td>82</td>
</tr>
<tr>
<td>10.5.2</td>
<td>Back-to-back sample mode</td>
<td>82</td>
</tr>
<tr>
<td>10.5.2.1</td>
<td>2-channel ADC input back-to-back sample mode</td>
<td>83</td>
</tr>
<tr>
<td>10.5.2.2</td>
<td>4-channel ADC input pre-trigger sample mode</td>
<td>83</td>
</tr>
<tr>
<td>11</td>
<td>Chapter 11: Using FlexTimer (FTM) via Programmable Delay Block (PDB) to Schedule ADC Conversion</td>
<td></td>
</tr>
<tr>
<td>11.1</td>
<td>Overview</td>
<td>85</td>
</tr>
<tr>
<td>11.2</td>
<td>Introduction</td>
<td>85</td>
</tr>
</tbody>
</table>
## Chapter 12
### FlexTimer Module (FTM)

<table>
<thead>
<tr>
<th>Section number</th>
<th>Title</th>
<th>Page</th>
</tr>
</thead>
<tbody>
<tr>
<td>12.1</td>
<td>Overview</td>
<td>91</td>
</tr>
<tr>
<td>12.2</td>
<td>Introduction</td>
<td>91</td>
</tr>
<tr>
<td>12.3</td>
<td>Features</td>
<td>91</td>
</tr>
<tr>
<td>12.3.1</td>
<td>FTM clock</td>
<td>92</td>
</tr>
<tr>
<td>12.3.2</td>
<td>Interrupts and DMA</td>
<td>92</td>
</tr>
<tr>
<td>12.3.3</td>
<td>Modes of operation</td>
<td>92</td>
</tr>
<tr>
<td>12.3.4</td>
<td>Updating MOD and CnV</td>
<td>93</td>
</tr>
<tr>
<td>12.3.5</td>
<td>FTM period</td>
<td>93</td>
</tr>
<tr>
<td>12.3.6</td>
<td>Additional features</td>
<td>94</td>
</tr>
<tr>
<td>12.4</td>
<td>Configuration examples</td>
<td>94</td>
</tr>
<tr>
<td>12.4.1</td>
<td>Example – Edge Aligned PWM and Input Capture Mode</td>
<td>94</td>
</tr>
</tbody>
</table>
Chapter 1
General System Setup (Software Considerations)

1.1 Software considerations

1.1.1 Overview
This chapter provides a quick look at some of the general characteristics of the Kinetis V series of MCUs. This is a brief introduction of the operation of the devices and typical software initialization.

For more information, see the device-specific reference manual and data sheet.

1.1.2 Code execution
The Kinetis V series features embedded Flash and SRAM memory for data storage and program execution.

1.1.3 Reset and booting
When the processor exits reset, it fetches the initial stack pointer (SP) from vector table offset 0 and the program counter (PC) from vector table offset 4. The initial vector table must be located in the flash memory at the base address (0x0000_0000). However, the vector table can be relocated to SRAM after the boot-up sequence if desired. This device supports booting from internal flash and RAM. This device supports booting from internal flash with the reset vectors located at addresses 0x0 (initial SP_main), 0x4 (initial PC), and RAM with the relocation of the exception vector table to RAM.

After fetching the stack pointer and program counter, the processor branches to the PC address and begins executing instructions.
For more information, see the "Reset and Boot" chapter of the device-specific reference manual.

1.1.3.1 Device state during reset

With the exception of the SWD pins, during reset the digital I/O pins go to a disabled (high impedance) state with internal pullups/pulldowns disabled. Pins with analog functionality will default to their analog functions.

1.1.3.2 Device state after reset

After reset, the digital I/O pins remain disabled until enabled by software. Also, interrupts are disabled and the clocks to most of the modules are off. The default clock mode after reset is FLL Engaged Internal (FEI) mode. In this mode, the system is clocked by the frequency-locked loop (FLL) using the slow internal reference clock as its reference. The watchdog timer is active; therefore it will need to be serviced, or disabled if debugging. The core clock, system clock, and flash clock are enabled after reset to support booting. Also, the flash memory controller cache and prefetch buffers are enabled.

1.1.4 Typical system initialization

The following is a summary of typical software initialization. The code snippets are taken from a platinum project written in IAR Embedded Workbench. This project is available in the Kinetis sample code which accompanies this guide.

1.1.4.1 Lowest level assembly routines

These routines are assembly source code found in the file crt0.s. The address of the start of this code is placed in the vector table offset 4 (initial program counter) so that it is executed first when the processor starts up. This is accomplished by labeling this section, exporting the label, and placing the label in the vector table. The vector table can be found in vectors.h. In this example the label used is __startup.

1.1.4.1.1 Initialize general purpose registers

As a general rule, it is recommended to initialize the processor general purpose registers (R0-R7) to zero. One way of doing this is with the LDR instruction.
LDR     r0,=0          ; Initialize the GPRs
LDR     r1,=0
LDR     r2,=0
LDR     r3,=0
LDR     r4,=0
LDR     r5,=0
LDR     r6,=0
LDR     r7,=0

1.1.4.1.1.1 Unmask interrupts at ARM® core

CPSIE   i               ; Unmask interrupts

1.1.4.1.1.2 Branch to start of C initialization code

import start
BL      start           ; call the C code

1.1.4.2 Startup routines

These routines are C source code found in the files start.c and sysinit.c. This code provides general system initialization that may be adapted depending on the application.

1.1.4.2.1 Disable watchdog

For code development and debugging, it is best to disable the watchdog. The watchdog can be disabled by first unlocking the watchdog followed by clearing the WDOGEN bit. Users should avoid any breakpoints in between the following code lines during debugging.

/* Disable the watchdog timer */
/* First unlock the watchdog so that we can write to registers */
DisableInterrupts;
WDOG>UNLOCK = 0xC520;
WDOG>UNLOCK = 0xD928; EnableInterrupts;
/* Clear the WDOG bit to disable the watchdog */
WDOG >STCTRLH & =~WDOG_STCTRLH_WDOGEN_MASK;

1.1.4.2.2 Initialize RAM

Depending on the application, the following steps may be required. First, copy the vector table from flash to RAM, copy initialized data from flash to RAM, clear the zero-initialized data section, and copy functions from flash to RAM.

1.1.4.2.3 Enable port clocks

To configure the I/O pin muxing options, the port clocks must first be enabled. This allows the pin functions to later be changed to the desired function for the application.
1.1.4.2.4 Ramp system clock to selected frequency

The Multipurpose clock generator (MCG) provides several options for clocking the system. Configure the MCG mode, reference source, and selected frequency output based on the needs of the system.

1.1.4.2.5 Enable UART for terminal communication

See the section describing UART in this document for more information.

1.1.4.2.6 Jump to start of main function for application

/* Jump to main process */
main();
Chapter 2
General System Setup (Hardware Considerations)

2.1 Hardware considerations

2.1.1 Overview

This chapter will outline the best practices for hardware design when using the Kinetis V series MCUs. The designer must consider numerous aspects when creating the system so that performance, cost, and quality meet the end-user expectations. Performance usually implies high speed digital signalling, but it also applies to accurate sampling of analog signals. Cost is influenced by component selection, of which the PCB may be the most expensive element. Quality involves manufacturability, reliability, and conformance to industry or governmental standards.

Evaluation boards are great for evaluating the operation and performance of the many features of Freescale MCUs. However, evaluation systems are not ideal examples for implementation of robust system design techniques. This document will mention some of the hardware techniques found on the Freescale Tower Systems, and will give recommendations that are more appropriate to conventional systems that are not required to implement all of the feature options.

2.1.2 Floorplan

The organization of the printed circuit board (PCB) depends on many factors. Typically, there are connectors, mechanical components, high speed signals, low speed signals, switches, and power domains, among others, that need to be considered. While placement of connectors and some mechanical components (switches, relays, and so on) is critical to the end product’s form, there are some basic recommendations that can significantly affect the electrical performance and electromagnetic compatibility (EMC) of the PCB assembly.
2.1.2.1 Connectors

The PCB should be organized so that all of the connectors are along one edge of the board and away from the MCU. The concept here is to prevent placing the MCU in between connectors that can become effective radiators when cables are attached. This also keeps the MCU from being in the path of high energy transients that can shoot across the board from one connector to another. Connectors may be placed on adjacent edges of the PCB if necessary, but only when the MCU is not in a direct path between the connectors.

Connector locations should allow for placement of filter components. Noise must be suppressed at the connector, before it can propagate onto the PCB. For more information on this topic, see the input filtering section.

2.1.3 PCB routing considerations

This section covers critical power and filtering aspects of PCB layout.

2.1.3.1 Power supply routing

Routing of power and ground to digital systems is a topic that is discussed and debated in many textbooks and references. The basic concept is to ensure that the MCU and other digital components have a low impedance path to the power supply. The typical guidance that was given for one and two layer PCBs was to use wide traces and few layer transitions. The recommendations for today’s high speed MCUs follow those given for high speed microprocessor systems – specifically, use planes for power and ground. This may raise the PCB cost, but the benefits of crosstalk reduction, reduction of RF emissions, and improved transient immunity can be realized with lower overall production and maintenance costs.

In general, the ground routing should take precedence over any other routing. Ground planes or traces should never be broken by signals. For packages with leads, like the LQFP, a ground plane directly below the MCU package is recommended to reduce RF emissions and improve transient immunity. All of the VSS pins of the MCU should be tied to a ground plane. Ground traces from a plane should be kept as short as possible as they are routed to circuitry on signal layers (top and bottom). Power planes may be broken to supply different voltages. All of the VDD pins of the MCU should be tied to
the proper power plane. Power traces from the planes should be kept as short as possible as they are routed to circuitry, such as pullups, filters, other logic and drivers, on the top and bottom layers. More information is given in the PCB layer stack-up section below.

### 2.1.3.2 Power supply decoupling and filtering

Bypass capacitors, while also called decoupling capacitors, are the storage elements that provide the instantaneous energy demanded by the high speed digital circuits.

Power supply bypass capacitors must be placed close to the MCU supply pins. The basic concept is that the bypass capacitor provides the instantaneous current for every logic transition within the MCU. Fortunately, each Kinetis MCU has a low voltage internal regulator for the MCU core logic, therefore the abrupt current demands of the internal high speed logic are not as critical. However, external signals demand energy from the power rails when they transition from one logic level to the other. The bypass capacitors provide the local filtering so that the effects of the external pin transitions are not reflected back to the power supply, which causes RF emissions.

The basic rule of placing bypass capacitors as close as possible to the MCU is still appropriate. The idea is to minimize the loop created by the capacitor between the VDD and VSS pins. The implementation of this rule depends on the number of mounting layers, how the supplies are routed, and the physical size of the capacitors:

- **Number of mounting layers** – PCBs with components mounted only on the top side will have a significant limitation on how close the bypass caps can be located due to the number of components that require space. PCBs that have components mounted on both sides of the PCB allow closer placement of the bypass capacitors.

- **Supply routing** – For Quad Flat Pack (QFP) packages, the power supply pins may be supplied radially to the MCU using traces rather than from planes. Although it is adequate to place the bypass capacitors close to the VDD and VSS pins on the traces leading to the MCU, it is better to have the ground side of the bypass capacitor tied to the ground plane (through a via and short trace) close to the VSS pin and the VDD side tied to the power plane (through a via and short trace) close to the VDD pin.

### 2.1.3.3 Oscillators

The Kinetis MCU starts up with an internal digitally controlled oscillator (DCO) to control the bus clocking, and then software can be used to enable an external oscillator if desired. The external oscillator for the multipurpose clock generator (MCG) can range from a 32.768 kHz crystal up to a 32 MHz crystal or ceramic resonator.
2.1.3.3.1 MCG oscillator

The high speed oscillator that can be used to source the MCG module is very versatile. The component choices for this oscillator are detailed in the device-specific reference manual. The placement of this crystal or resonator is described here.

The EXTAL and XTAL pins are located on the outside pad ring of the BGA package and on corner pins of the LQFP/QFN package. This allows room for placement and routing of the crystal or resonator on the top layer, close to the MCU. The feedback resistor and load capacitors, if needed, can be placed on the top layer as well. See Figure 2-1, Figure 2-2, and Figure 2-3.

Note that the low power modes of this oscillator do not require a feedback resistor, and may not require external load capacitors. See the device-specific reference manual for details. This makes it as simple as possible because only one component has to be placed and routed. Low power oscillators are more susceptible to interference by system generated noise, therefore the guidelines for crystal routing are important.

The crystal or resonator must be located close to the MCU. No signals of any kind should be routed on the layer directly below the crystal. The load capacitors and ground of the crystal package must be connected to a single ground trace coming from the closest VSS pin or the recommended ground under the MCU. An unbroken ground plane on the layer directly below the crystal is recommended. A ground pour must be placed around the crystal and its load components to protect it from crosstalk from adjacent signals on the mounting layer.

![Figure 2-1. Typical crystal circuit](image-url)
Figure 2-2. Crystal layout for low power oscillator
2.1.3.4 General filtering

General purpose I/O pins should have adequate isolation and filtering from transients.

2.1.3.4.1 RESET\_b and NMI\_b

The RESET\_b pin, if enabled, should have a 100 nF capacitor close to the MCU for transient protection. The NMI\_b pin, if enabled, must not have any capacitance connected to it. Each pin, when enabled as their default function, has a weak internal pullup, but an external 4.7 kΩ to 10 kΩ pullup is recommended. As with power pin filtering, it is recommended to minimize the ground loop for the capacitor and the VDD loop for the pullup resistor for these pins.
The RESET_b pin also has a configurable digital filter to reject potential noise on this input after power-up. The configuration bits are located in the RCM_RPFC register. While use of this filter may negate the need for the pullup and capacitor mentioned above, it is still recommended to use external filtering in electrically noisy environments.

### 2.1.3.4.2 General purpose I/O

General purpose inputs, such as low speed inputs, timer inputs, and signals from off-board should have low pass filters (series resistor and capacitor to ground) to prevent data corruption due to crosstalk or transients. The filter capacitor should be placed close to the MCU pin, while the resistor can be placed closer to the source.

Inputs that come from connectors should have low pass filtering at the connector to prevent noise from propagating onto the PCB. This requires a robust ground structure around the connector. Series resistors for signals that come from off-board should be placed as close to the connector as possible. A filter cap closer to the MCU input pin may be required if the signal trace length is very long and can pick up noise from other circuits.

Output pins must not have any significant capacitance placed close to the MCU. These signals can have capacitors at the load or connector to minimize radiated emissions if necessary.

**NOTE**

Must ensure that VDD be powered prior to /RESET_B and all others GPIO pins.

### 2.1.3.4.3 Analog inputs

Analog inputs should also have low pass filters. The challenge with analog inputs, especially for high resolution analog-to-digital conversions, is that the filter design needs to consider the source impedance and sample time rather than a simple cutoff frequency. This topic cannot be discussed in detail here, but the general concept is that fast sample times will require smaller capacitor values and source impedances than slow sample times. Higher resolution inputs may require smaller capacitor values and source impedances than lower resolution inputs.

In general, capacitor values can range from 10 pF for high speed conversions to 1 uF for low speed conversions. Series resistors are added for RC filter and a typical value is 100 Ohms.
2.1.4 PCB layer stack-up

The Kinetis V series MCUs are high speed integrated circuits. Care must be taken in the PCB design to ensure that fast signal transitions, such as rise/fall times and continuous frequencies, do not cause RF emissions. Likewise, transient energy that enters the system needs to be suppressed before it can affect the system operation (compatibility). The guidance from high speed PCB designers is to have all signals routed within one dielectric (core or prepreg) of a return path, which usually is a ground plane on a multi-layer PCB and an adjacent ground on a two layer PCB. This allows return currents to predictably flow back to the source without affecting other circuits, which is the primary cause of radiated emissions in electronic systems. This approach requires full planes within the PCB layer stack and partial planes (copper pours) on signal layers where possible. All ground planes and ground pours must be connected with plenty of vias. Likewise, all “like” power planes and power pours must be connected with plenty of vias.

Recommended layer stackups:

4-Layer PCB A:
- Layer 1 (top – MCU location)—Ground plane and pads for top mounted components, no signals
- Layer 2 (inner)—Signals and power plane
- Thick core
- Layer 3 (inner)—Signals and power plane
- Layer 4 (bottom)—Ground plane and pads for bottom mounted components, no signals

4-Layer PCB B:
- Layer 1 (top – MCU location)—Signals and poured power
- Layer 2 (inner)—Ground plane
- Thick core
- Layer 3 (inner)—Ground plane
- Layer 4 (bottom)—Signals and poured power

6-Layer PCB A:
- Layer 1 (top – MCU)—Power plane and pads for top mounted components, no signals
- Layer 2 (inner)—Signals and ground plane
- Layer 3 (inner)—Power plane
- Layer 4 (inner)—Ground plane
- Layer 5 (inner)—Signals and power plane
- Layer 6 (bottom)—Ground plane and pads for bottom mounted components, no signals

6-Layer PCB B:
Layer 1 (top – MCU)—Signals and power plane
Layer 2 (inner)—Ground plane
Layer 3 (inner)—Signals and power plane
Layer 4 (inner)—Ground plane
Layer 5 (inner)—Power plane
Layer 6 (bottom)—Signals and ground plane

6-Layer PCB C:
Layer 1 (top – MCU)—Signals and power plane
Layer 2 (inner)—Ground plane
Layer 3 (inner)—Signals and power plane
Layer 4 (inner)—Signals and ground plane
Layer 5 (inner)—Power plane
Layer 6 (bottom)—Signals and ground plane

8-Layer PCB A:
Layer 1 (top – MCU)—Signals
Layer 2 (inner)—Ground plane
Layer 3 (inner)—Signals
Layer 4 (inner)—Power plane
Layer 5 (inner)—Ground plane
Layer 6 (inner)—Signals
Layer 7 (inner)—Ground plane
Layer 8 (bottom)—Signals

8-Layer PCB B:
Layer 1 (top – MCU)—Signals and power plane
Layer 2 (inner)—Ground plane
Layer 3 (inner)—Signals and power plane
Layer 4 (inner)—Ground plane
Layer 5 (inner)—Power plane
Layer 6 (inner)—Signals and ground plane
Layer 7 (inner)—Power plane
Layer 8 (bottom)—Signals and ground plane

8-Layer PCB C:
Layer 1 (top – MCU)—Signals and ground plane
Layer 2 (inner)—Power plane
Layer 3 (inner)—Ground plane
Layer 4 (inner)—Signals
Thick core
Layer 5 (inner)—Signals
Layer 6 (inner)—Ground plane
Layer 7 (inner)—Power plane
Layer 8 (bottom)—Signals and ground plane

8-Layer PCB D:
Layer 1 (top – MCU)—Signals and ground plane
Layer 2 (inner)—Power plane
Layer 3 (inner)—Ground plane
Layer 4 (inner)—Signals and power plane
Thick core
Layer 5 (inner)—Signals and power plane
Layer 6 (inner)—Ground plane
Layer 7 (inner)—Power plane
Layer 8 (bottom)—Signals and ground plane

In general, avoid placing one signal layer adjacent to another signal layer.

### 2.1.5 Other module hardware considerations

#### 2.1.5.1 Debug interface

The Kinetis V series MCUs use the Cortex Debug interfaces for debugging and programming. The 19-pin Cortex Debug interfaces provides connections for Serial Wire debugging, as well as target power. The 9-pin Cortex Debug interfaces provides connections for Serial Wire debugging only. Figure 2-4 shows the 20-pin header implementation with 19 pins populated. Figure 2-5 shows the 10-pin header implementation with 9 pins populated as used on the TWR system and Freedom boards.
The debug signals are multiplexed with general purpose I/O pins, therefore some signals will require proper biasing to select the operating mode. The SWD_CLK pin has an internal pull down device and SWD_DIO has an internal pull up device. The connectors...
Other module hardware considerations

for this interface are keyed dual row 0.050” centered headers. When implementing either of these headers on a target system, pin 7 must be depopulated to use the 19-pin or 9-pin adapters from the debug tool. The Samtec part numbers for these connectors are:

- FTSH-110-01-L-DV-K – 20-pin keyed connector
- FTSH-105-01-L-DV-K – 10-pin keyed connector
- FTSH-110-01-L-DV – 20-pin connector, no key
- FTSH-105-01-L-DV – 10-pin connector, no key

This interface is useful during the development phase of a project. The header may not need to be populated in the production phase of the project, but the PCB pads should be kept available for future debugging purposes.
Chapter 3
Nested Vector Interrupt Controller (NVIC)

3.1 NVIC

3.1.1 Overview

This chapter shows how the NVIC is integrated into the Kinetis MCUs and how to configure it and set-up module interrupts. It also demonstrates the steps to set the interrupts for the desired peripheral and how to locate the vector table from flash to RAM.

3.1.1.1 Introduction

The NVIC is a standard module on the ARM® Cortex®-M series. This module is closely integrated with the core and provides very low latency entering and exiting an interrupt service routine (ISR). It takes 15 cycles to exit an ISR, unless the exit from the interrupt is into another pending ISR. In this case, the MCU tail-chains and the exit and re-entry takes 11 cycles.

The NVIC provides four different interrupt priorities which can be used to control the order in which interrupts must be serviced. Priorities are 0-3, with 0 receiving the highest priority. For example, in a motor-control application, if a timer interrupt and UART occur simultaneously, the timer interrupt that moves the motor is more critical than the UART interrupt receiving a character. The timer priority must be set higher than the UART.
3.1.1.2 Features

On Kinetis V1x series MCUs the NVIC provides up to 48 interrupt sources including 16 that are core specific. It also implements up to four priority levels that are fully programmable. The NVIC uses a vector table to manage the interrupts. This vector table can be stored in either flash or RAM, depending on the application.

### Table 3-1. Core exceptions

<table>
<thead>
<tr>
<th>Address</th>
<th>Vector</th>
<th>IRQ</th>
<th>Source module</th>
<th>Source description</th>
</tr>
</thead>
<tbody>
<tr>
<td>ARM Core System Handler Vectors</td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>0x0000_0000</td>
<td>0</td>
<td>—</td>
<td>ARM core</td>
<td>Initial stack pointer</td>
</tr>
<tr>
<td></td>
<td>1</td>
<td>—</td>
<td>ARM core</td>
<td>Initial program Counter</td>
</tr>
<tr>
<td></td>
<td>2</td>
<td>—</td>
<td>ARM core</td>
<td>Non-maskable Interrupt (NMI)</td>
</tr>
<tr>
<td></td>
<td>3</td>
<td>—</td>
<td>ARM core</td>
<td>Hard fault</td>
</tr>
<tr>
<td></td>
<td>11</td>
<td>—</td>
<td>ARM core</td>
<td>SVCall</td>
</tr>
<tr>
<td></td>
<td>12</td>
<td>—</td>
<td>—</td>
<td>—</td>
</tr>
<tr>
<td></td>
<td>14</td>
<td>—</td>
<td>ARM core</td>
<td>Pendable request for system service</td>
</tr>
<tr>
<td></td>
<td>15</td>
<td>—</td>
<td>ARM core</td>
<td>System tick timer(SysTick)</td>
</tr>
</tbody>
</table>

3.1.2 Configuration examples

The NVIC is easy to configure, as demonstrated in the following examples. The first example shows how to configure the NVIC for a module, using the low power timer (LPTMR) as a base. The second example shows how to locate the vector table from the flash to RAM.

3.1.2.1 Configuring the NVIC

Configuring the NVIC for the specific module involves writing three registers: NVIC Set Enable Register (NVIC->ISERx), NVIC Clear Pending Register (NVIC->ICPR[0]), and NVIC Interrupt Priority (NVIC->IP[IRQn]). After the NVIC is configured and the desired peripheral has its interrupts enabled, the NVIC serves any pending request from that module by going to the module’s ISR.

3.1.2.1.1 Code example and explanation

This example shows how to set up the NVIC for a specific module, using the LPTMR. The steps to configure the NVIC for this module are:
1. Identify the vector number and the IRQ number of the module from the vector table in the device-specific reference manual in the section *Interrupt Channel Assignments*. For the LPTMR the vector is 44 and IRQ is 28.

2. Identify which bit to set, perform a modulo operation dividing the IRQ number by 32. This number is used to enable the interrupt on NVIC->ISER[0] and to clear the pending interrupts from NVIC->ICPR[0].

Example:

\[
\text{LPTMR BIT} = 28 \mod 32
\]

\[
\text{LPTMR BIT} = 28
\]

3. At this point, the interrupt for the LPTMR can be configured:

\[
\begin{align*}
\text{NVIC-&gt;ICPR}[0] &= \{1 < 28\}; \quad \text{//Clear any pending interrupts on LPTMR} \\
\text{NVIC-&gt;ISER}[0] &= \{1 < 28\}; \quad \text{//Enable interrupts from LPTMR module}
\end{align*}
\]

4. Next, set the interrupt priority level. This is application dependent. On Kinetis V1x series MCUs there are four different priority levels. To set the priority, write to the NVIC-&gt;IP[IRQn] register; the "IRQn" represents the IRQ number divided by 4. Note the most significant nibble is used to set up the priority, the lower nibble is reserved and reads as zero. The LPTMR example sets the priority to priority 3:

\[
\begin{align*}
\text{NVIC-&gt;IP[&lt;IP IDX(IRQn)&gt;]} &= (\text{NVIC-&gt;IP[&lt;IP IDX(IRQn)&gt;]} &\& (0xFF &lt;&lt; _BIT SHIFT (IRQn))) | \\
&\quad (\text{priority } &\& (8 - _NVIC PRIO BITS)) & 0xFF) &\& _BIT SHIFT (IRQn)); \quad \text{//Set Priority to priority 3 to the LPTMR module}
\end{align*}
\]

5. After the NVIC registers are set up, finish the peripheral configuration that must enable the interrupt.

6. In the ISR, clear the peripheral interrupt flag and read back the status register to avoid re-entrance. For this example:

```c
void LPTMR_Isr (void)
{
    LPTMR0-&gt;CSR|=LPTMR_CSR_TCP_MASK; //Clear LPTMR Compare flag
    LPTMR0-&gt;CSR = ( LPTMR_CSR_TEN_MASK |
        LPTMR_CSR_TIE_MASK |
        LPTMR_CSR_TCP_MASK );
    /*ISR code goes here*/
}
```

### 3.1.2.2 Relocating the vector table

Some applications need the vector table to be located in RAM. For example in an RTOS implementation, the vector table needs to be in RAM, which allows the Kernel to install ISRs by modifying the vector table during runtime.
The NVIC provides a simple way to reallocate the vector table. The user needs to set up the Vector Table Offset Register (VTOR) with the address offset for the new position.

If you plan to store the vector table in RAM, you must first copy the table from the flash to RAM. Also note that in some low power modes, a portion of the RAM will not be powered, which can lead to a vector table corruption. In this case, locate the vector table in the flash prior to entering a low power mode.

### 3.1.2.2.1 Code example and explanation

The CM0+ core adds support for a programmable Vector Table Offset Register (VTOR) to relocate the exception vector table. This device supports booting from internal flash. The vector table is initially in flash. If the vector table is needed in RAM, move it in this manner:

1. Copy the entire vector table from flash to RAM. The linker command file labels are useful in this step. Refer to the following sample code:

   ```c
   /*Address for VECTOR_TABLE and VECTOR_RAM come from the linker file*/
   extern uint32 __VECTOR_TABLE[];
   extern uint32 __VECTOR_RAM[];
   
   /* Copy the vector table to RAM */
   if (__VECTOR_RAM != __VECTOR_TABLE)
   {
     for (n = 0; n < 0x104; n++)
       __VECTOR_RAM[n] = __VECTOR_TABLE[n];
   }
   
   2. After the table has been copied, set the proper offset for the VTOR register:

      /* Point the VTOR to the new copy of the vector table */
      write_vtor((uint32)__VECTOR_RAM);
   
   It is important to follow these steps in order, to ensure that there is always a valid vector table.
Chapter 4
Clocking System

4.1 Clocking

4.1.1 Overview
This chapter will discuss the clocking system and the multipurpose clock generator (MCG) module. Examples will provide an overview of how to switch between the MCG modes and specifically how to enable the on-chip FLL for high-speed operation. Clock selection options will be discussed for the RTC.

4.1.2 Features
An example of the clocking system is summarized in the following figure. Not all clock sources will be available on specific devices. Refer to the individual device reference manual for full details of the available clock sources.
The system level clocks are provided by the MCG. The MCG consists of:
- Two individually trimmable internal reference clocks (IRC), a slow IRC with a frequency of ~32 kHz and a fast IRC with a frequency of ~4 MHz, which can be reduced by means of the FCRDIV divider
- Frequency locked loop (FLL) using the slow IRC or an external source as the reference clock
- Auto trim machine (ATM) to allow both of the IRCs to be trimmed to a custom frequency using an externally-generated reference clock

The clocks provided by the MCG are summarized as follows:
- **MCGOUTCLK** – The main system clock used to generate the core, bus, and memory clocks. It can be generated from one of the on-chip reference oscillators, the on-chip crystal/resonator oscillator, an externally generated square wave clock, or the FLL.

**Figure 4-1. Clock distribution diagram**
• MCGFLCLK – The output of the FLL and is available any time the FLL is enabled.
• MCGIRCLK – The output of the selected IRC. The selected IRC will be enabled whenever this clock is selected.

In addition to the clocks provided by the MCG, there are three other system level clock sources available for use by various peripheral modules:
• OSCERCLK – The clock provided by the system oscillator and is the output of the oscillator or the external square wave clock source.
• ERCLK32K – The output of the system oscillator if it is configured in low power mode at 32 kHz, the external RTC_CLKIN path or the low power oscillator (LPO).
• LPO – The output of the low power oscillator. It is an on-chip, very low power oscillator with an output of approximately 1 kHz that is available in all run and low power modes except VLLS0.

### 4.1.3 Configuration examples

The MCG can be configured in one of several modes to provide a flexible means of providing clocks to the system for a wide range of applications.

After exiting reset, or recovering from a very low leakage state, the MCG will be in FLL engaged internal (FEI) mode with MCGCLKOUT at 20.97 MHz, assuming a factory trimmed slow IRC frequency of 32.768 kHz. If a different MCG mode is required, the MCG can be transitioned to that mode under software control.

It is only possible to transition directly to certain MCG modes. Refer to the individual device reference manual for details on this. It may be required to transition through several modes to reach the desired MCG mode. When transitioning from one clock mode to another, you must ensure that you have fully entered that mode before moving to the next mode. The mcg.c file within the sample code contains examples of how to perform all the individual clock mode transitions. The fei_fee function causes the MCG mode transition from FEI to FEE. The specific MCG register operations will be discussed below.

In this example, the FLL is configured to use an external 10 MHz from the crystal oscillator to generate a 75 MHz output frequency which is a typical configuration for FEE mode.

A code example for transition from FEI to FEE follows:

```c
int fei_fee(int crystal_val, unsigned char hgo_val, unsigned char erefs_val)
{
    unsigned char frdiv_val;
    unsigned char temp_reg;
    // short i;
    int mcg_out, fll_ref_freq, i;
```
// check if in FEI mode
/*
  if (!(((MCG -> S & MCG_S_CLKST_MASK) >> MCG_S_CLKST_SHIFT) == 0x0) &
  // check CLKS mux
  (MCG -> S & MCG_S_IREFST_MASK))) // check PLLS mux
  has selected PLL

  { return 0x1; /* return error code */
  }

  // check external frequency is less than the maximum frequency
  if (crystal_val > 50000000) {return 0x21;}

  // check crystal frequency is within spec. if crystal osc is being used
  if (erefs_val)
    { if (crystal_val > 40000) && (crystal_val < 3000000) ||
      (crystal_val > 32000000)) {return 0x22;} // return error if one of the available
      crystal options is not available

  // make sure HGO will never be greater than 1. Could return an error instead if desired.
  if (hgo_val > 0)
    { hgo_val = 1; // force hgo_val to 1 if > 0
    }

  OSC0 -> CR = OSC_CR_ERCLKEN_MASK
  OSC_CR_EREFSTEN_MASK
  OSC_CR_SC16P_MASK;

  // configure the MCG -> C2 register
  // the RANGE value is determined by the external frequency. Since the RANGE parameter
  // it still needs to be set correctly even if the oscillator is not being used
  temp_reg & = ~(MCG_C2_RANGE0_MASK | MCG_C2_HGO0_MASK | MCG_C2_EREFS0_MASK); // clear
  fields before writing new values
  if (crystal_val ≤ 40000)
    { temp_reg | = (MCG_C2_RANGE0(0) | (hgo_val << MCG_C2_HGO0_SHIFT) | (erefs_val <<
    MCG_C2_EREFS0_SHIFT));
    }
  else if (crystal_val ≤ 8000000)
    { temp_reg | = (MCG_C2_RANGE0(1) | (hgo_val << MCG_C2_HGO0_SHIFT) | (erefs_val <<
    MCG_C2_EREFS0_SHIFT));
    }
  else
    { temp_reg | = (MCG_C2_RANGE0(2) | (hgo_val << MCG_C2_HGO0_SHIFT) | (erefs_val <<
    MCG_C2_EREFS0_SHIFT));
    }

  MCG -> C2 = temp_reg;
  // if the external oscillator is used need to wait for OSCINIT to set
  if (erefs_val)
    { for (i = 0; i < 20000000; i++)
      { if (MCG -> S & MCG_S_OSCINIT0_MASK) break; // jump out early if OSCINIT sets before
        loop finishes
      }
     if (!((MCG -> S & MCG_S_OSCINIT0_MASK)) return 0x23; // check bit is really set and
     return with error if not set
   */

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Freescale Semiconductor, Inc.
// determine FRDIV based on reference clock frequency
// since the external frequency has already been checked only the maximum frequency for each
FRDIV value needs to be compared here.
if (crystal_val ≤ 1250000) {frdiv_val = 0;}
else if (crystal_val ≤ 2500000) {frdiv_val = 1;}
else if (crystal_val ≤ 5000000) {frdiv_val = 2;}
else if (crystal_val ≤ 10000000) {frdiv_val = 3;}
else if (crystal_val ≤ 20000000) {frdiv_val = 4;}
else {frdiv_val = 5;}

// The FLL ref clk divide value depends on FRDIV and the RANGE value
if (((MCG -> C2 & MCG_C2_RANGE0_MASK) >> MCG_C2_RANGE0_SHIFT) > 0)
{
    fll_ref_freq = ((crystal_val) / (32 << frdiv_val));
}
else
{
    fll_ref_freq = ((crystal_val) / (1 << frdiv_val));
}
if( crystal_val == 32768 )
{
    MCG -> C4 |= MCG_C4_DMX32_MASK | MCG_C4_DRST_DRS(1);
}

//KV10 will run up to 75 MHz, core clock = 10 MHz/32*8 * 1920 = 74.9 MHz
MCG -> C4 |= MCG_C4_DRST_DRS(2);
// Check resulting FLL frequency
mcg_out = fll_freq(fll_ref_freq); // FLL reference frequency calculated from ext ref freq
and FRDIV
if (mcg_out < 0x5B) {return mcg_out;} // If error code returned, return the code to
calling function

// Select external oscillator and Reference Divider and clear IREFS to start ext osc
// If IRCLK is required it must be enabled outside of this driver, existing state will be
maintained
// CLKS=0, FRDIV=frdiv_val, IREFS=0, IRCLKEN=0, IREFSTEN=0
   temp_reg = MCG -> C1;
   temp_reg &= ~(MCG_C1_CLKS_MASK | MCG_C1_FRDIV_MASK | MCG_C1_IREFS_MASK); // Clear values
   in these fields
   temp_reg |= (MCG_C1_CLKS(0) | MCG_C1_FRDIV(frdiv_val)); // Set the required CLKS and FRDIV
values
   MCG -> C1 = temp_reg;

// wait for Reference clock Status bit to clear
for (i = 0 ; i < 20000 ; i++)
{
    if (!(MCG -> S & MCG_S_IREFST_MASK)) break; // jump out early if IREFST clears before
loop finishes
}
if (MCG -> S & MCG_S_IREFST_MASK) return 0x11; // check bit is really clear and return
with error if not set

// Now in FBE
// It is recommended that the clock monitor is enabled when using an external clock as the
clock source/reference.
// It is enabled here but can be removed if this is not required.
// MCG -> C6 |= MCG_C6_CME_MASK;
return mcg_out; // MCGOUT frequency equals FLL frequency
} // fei_fee
4.1.4 Clocking system device hardware implementation

The main system oscillator can be configured in various ways depending on the crystal frequency and mode being used. Refer to the device-specific reference manual for details. When the oscillator is configured for low power, an integrated oscillator feedback resistor is provided. The oscillator also has programmable internal load capacitors when it is configured as a 32kHz oscillator (RANGE = 0). The internal crystal load capacitors are selectable in software to provide up to 30 pF, in 2 pF increments, for each of the EXTAL and XTAL pins. This provides an effective series capacitive load of up to 15 pF. The parasitic capacitance of the PCB should also be included in the calculation of the total crystal load. The combination of these two values will often mean that no external load capacitors are required when using a 32 kHz crystal.

If either of the oscillator pins are not being used, they may be left unconnected in their default reset configuration or may be used as GPIO.

4.1.5 Layout guidelines for general routing and placement

Use the following general routing and placement guidelines when laying out a new design. These guidelines will help to minimize electromagnetic compatibility (EMC) problems:

- To minimize parasitic elements, surface mount components must be used where possible.
- All components must be placed as close to the MCU as possible.
- If external load capacitors are required, they must use a common ground connection shared in the center.
- If the crystal, or resonator, has a ground connection, it must be connected to the common ground of the load capacitors.
- Where possible:
  - Keep high-speed IO signals as far from the EXTAL and XTAL signals as possible.
  - Do not route signals under oscillator components - on same the layer or layer below.
  - Select the functions of pins close to EXTAL and XTAL to have minimal switching to reduce injected noise.
4.1.6 References

The following list of application notes associated with crystal oscillators are available on the Freescale website at www.freescale.com. They discuss common oscillator characteristics, potential problems, and troubleshooting guidelines:

- AN1706: Microcontroller Oscillator Circuit Design Considerations
- AN1783: Determining MCU Oscillator Start-Up Parameters
- AN2606: Practical Considerations for Working With Low-Frequency Oscillators
- AN3208: Crystal Oscillator Troubleshooting Guide
Chapter 5
Power Management Control (PMC/SMC/LLWU/RCM)

5.1 Introduction
This chapter is a brief description of the power management features of the Kinetis V series 32-bit MCU.

There are four modules covered in this chapter:

- Power Management Controller (PMC)
- System Mode Controller (SMC)
- Low Leakage Wake-up Unit (LLWU)
- Reset Control Module (RCM)

5.2 Using the power management controller

5.2.1 Overview
This section will demonstrate how to use the power management controller (PMC) to protect an MCU from unexpected low $V_{DD}$ events. References to other protection options will also be made.

5.2.2 Using the low voltage detection system

5.2.2.1 POR and LVD features
The POR and LVD functions allow protection of memory contents from brown out conditions and the operation of the MCU below the specified VDD levels. As noted in the module operation in the low power modes section, the LVD circuit is available only
in RUN, WAIT, and STOP modes. POR circuitry is on in all modes and can be optionally
disabled in VLLS0. The user has control over whether LVD is used and whether the POR
is enabled in the lowest power mode (VLLS0). When using the low voltage detect
features, the user has full control over the LVD and LVW trip voltages. The LVW is a
warning detect circuit and the LVD is reset detect circuit.

As voltage falls below the warning level, the LVW circuit flags the warning event and
can cause an interrupt. If the voltage continues to fall, the LVD circuit flags the detect
event and can either cause a reset or an interrupt. The user can choose what action to take
in the interrupt service routine. If a detect is selected to drive reset, the LVD circuit holds
the MCU in reset until the supply voltage rises above the detect threshold.

The POR circuit for the MCU will hold the MCU in reset based upon the VDD voltage.
Before entering the VLLS0 low power mode, the user can choose to disable the POR
circuit. Because the MCU is switched off in VLLS0, the POR protection is not really
needed and can be disabled. This saves a few hundred nano amps of power while the
MCU is in this mode.

If the POR circuit is disabled in VLLS0, the MCU will continue to hold the state of the
pins until the VDD levels are much lower than the POR trip voltage levels.

Exiting VLLS0 follows the reset mode. The POR circuit is reenabled protecting the MCU
operation during the recovery.

5.2.2.2 Configuration examples

LVD and LVW initialization code is given below: Notice the comments describing the
chosen settings. You should select the parameter options for your application. The NVIC
vector flag may be set and is cleared if interrupts are enabled. The Interrupt is enabled in
the NVIC in this initialization with the call to function enable_irq(LVD_irq_no):

```c
/********************************************/
/* LVD and LVD initialization routine. */
/* sets up the LVD and LVW control registers */
/* This function can be used to set up the low voltage detect */
/* and warning. While the device is in the very low power or low */
/* leakage modes, the LVD system is disabled regardless of LVDSCL */
/* settings. To protect systems that must have LVD always on, */
/* configure the SMC's power mode protection register (PMPROT) */
/* to disallow any very low power or low leakage modes from */
/* being enabled. */
/* Parameters: */
/* lvd_select = 0x00 Low trip point selected (V LVD = V LVDL ) */
/* = 0x01 High trip point selected (V LVD = V LVDH ) */
/* = 0x10 Reserved */
/* = 0x11 Reserved */
/* lvd_reset_enable = 0x00 LVDF does not generate hardware resets */
/* = 0x10 Force an MCU reset when LVDF = 1 */
/* lvd_int_enable = 0x00 Hardware interrupt disabled */
```

Kinetis V Series Peripheral Module Quick Reference, Rev. 0, 02/2014

Freescale Semiconductor, Inc.
void LVD_Initailize(unsigned char lvd_select,
unsigned char lvd_reset_enable,
unsigned char lvd_int_enable,
unsigned char lvw_select,
unsigned char lvw_int_enable){
    /*enable LVD Reset ? LVD Interrupt.select high or low LVD */
    PMC -> LVDSC1 = PMC_LVDSC1_LVDAACK_MASK |
                    lvd_int_enable      |
                    PMC_LVDSC1_LVDV(lvd_select);
    /* select LVW level 1,2,3 or 4 */
    PMC -> LVDSC2 = PMC_LVDSC2_LVWACK_MASK |
                    lvw_int_enable      |
                    PMC_LVDSC2_LVWV(lvw_select);
    /* if interrupts requested
     clear pending flags in NVIC and enable interrupts */
    if (((PMC -> LVDSC1 & PMC_LVDSC1_LVDF_MASK)
         >>= PMC_LVDSC1_LVDIE_SHIFT) |
         ((PMC -> LVDSC2 & PMC_LVDSC2_LVWIE_MASK)
         >>= PMC_LVDSC2_LVWIE_SHIFT))
        {
            enable_irq(LVD_irq_no); // ready for this interrupt.
        }
}

5.2.2.3 Interrupt code example and explanation

The LVD circuitry can be programmed to cause an interrupt. You should create a service routine to clear the flags and react appropriately. An example of such an interrupt service routine is given.

To clear a warning or detect interrupt flag two things must happen:

1. The VDD voltage must return to a nominal voltage above the threshold.
2. A write to the LVDACK bit must be done to clear the LVDF indicator or a write to the LVWACK bit must be done to clear the LVWF indicator.

If the ACK bit is written and the voltage does not go back above the threshold, the interrupt flag will not clear and the interrupt routine will be reentered.

void pmc_lvd_isr(void)
{
    if (PMC -> LVDSC1 & PMC_LVDSC1_LVDIE_MASK)
        printf("[LVD_isr]LV DETECT interrupt occurred");
    if (PMC -> LVDSC2 & PMC_LVDSC2_LVWIE_MASK)
        printf("[LVD_isr]LV WARNING interrupt occurred");
}
5.2.2.4 Hardware implementation

**RESET PIN:** The reset pin is an open drain and has an internal pullup device. The pin is driven out if the internal circuitry detects a reset. This is true for all resets, except when there is a recovery from the VLLSx modes.

Although the wake-up recovery from VLLSx modes is through the reset flow, the reset pin is not driven out of the MCU. The reason for this is that I/O is held in the pre-low-power mode entry state so the internal reset action is blocked from being driven out.

If reset is driven low for longer than minimum pulse width to pass the analog filter and the digital filter settings, the MCU will wake from any low-power mode and the PIN bit in the RCM_SRS0 register will be set.

The reset pin can be disabled by clearing the RESET_PIN_CFG bit in the Flash Option Register (FOPT).

**VDD:** The VDD supply pins can be driven between 1.71 V and 3.6 V DC.

The following diagram shows a representative timing diagram during POR.

![Representative timing diagram during POR](image-url)
The following diagram shows the observed behavior of the reset pin during a ramp of VDD. In both of the following diagrams RESET asserts initially as the POR circuit is powered up. Next RESET is released when untrimmed LVD level is reached. Next RESET is asserted when LVD trim register is loaded, followed by RESET being released when trimmed LVD level is reached.

**Figure 5-2. Observed RESET pin behavior during normal slow VDD rise**

The following diagram shows the observed behavior of the reset pin during a fast ramp of VDD.

**Figure 5-3. Observed RESET pin behavior during normal fast VDD rise**
5.3 Using the system mode controller

5.3.1 Overview

This section will demonstrate how to use the system mode controller (SMC). The SMC is responsible for controlling the entry and exit from all of the run, wait, and stop modes of the MCU. This module works in conjunction with the RCM, PMC, and the LLWU to wake-up the MCU and move between power modes.

5.3.1.1 Introduction

There are 10 power modes and some new clocking options. These modes and options are described below.

1. Run — Default Operation of the MCU out of Reset, On-chip voltage regulator is On, full capability.
2. Very Low Power Run (VLPR) — On-chip voltage regulator is in a mode that supplies only enough power to run the MCU in a reduced frequency. Core clock up to 4 MHz and Bus frequency up to 1 MHz.
3. Wait — ARM core enters Sleep mode, NVIC remains sensitive to interrupts, Peripherals Continue to be clocked.
4. Stop — ARM core enters DeepSleep mode, NVIC is disabled, WIC is used to wake up from interrupt, peripheral clocks are stopped.
5. Very Low Power Wait (VLPW) — ARM core enters Sleep mode, NVIC remains sensitive to interrupts (FCLK = ON), On-chip voltage regulator is in a mode that supplies only enough power to run the MCU at a reduced frequency.
6. Very Low Power Stop (VLPS) — ARM core enters DeepSleep mode, NVIC is disabled (FCLK = OFF), WIC is used to wake up from interrupt, peripheral clocks are stopped, On-chip voltage regulator is in a mode that supplies only enough power to run the MCU at a reduced frequency, all SRAMs are operating (content retained and I/O states held).
7. Very Low Leakage Stop3 (VLLS3) — ARM core enters SleepDeep mode, NVIC is disabled, LLWU is used to wake up, peripheral clocks are stopped, all SRAMs are operating (content retained and I/O states held), and most modules are disabled.
8. Very Low Leakage Stop 1 (VLLS1) — ARM core enters SleepDeep mode, NVIC is disabled, LLWU is used to wake up, peripheral clocks are stopped, all SRAMs are powered down, and I/O states held. Most modules are disabled.
9. Very Low Leakage Stop 0 (VLLS0) — Lowest Power Mode ARM core enters SleepDeep mode, NVIC is disabled, LLWU is used to wake up, peripheral clocks are...
stopped, All SRAMs are powered down, and I/O states held. Most modules are
disabled, LPO shut down, optional POR brown-out detection.

The modules available in each of the power modes are described in a table. Please see
Module operation in low-power modes for the details of the module operations in each of
the low-power modes.

### 5.3.1.2 Entering and exiting power modes

SMC controls entry into and exit from each of the power modes. The WFI instruction
invokes wait and stop modes for the chip. The processor exits the low-power mode via an
interrupt. For VLLSx modes, the wake-up sources are limited to LLWU generated wake-
ups, NMI pin, or RESET pin assertions. When the NMI pin or RESET pin have been
disabled through associated FOPT settings, then these pins are ignored as wake-up
sources. The wake-up flow from VLLSx is always through reset.

**NOTE**

The WFE instruction can have the side effect of entering a low-
power mode, but that is not its intended usage. See ARM
documentation for more on the WFE instruction.

On VLLSx recoveries, the I/O pins continue to be held in a static state after code
execution begins, allowing software to reconfigure the system before unlocking the I/O.
RAM is retained in VLLS3 only.

### 5.3.2 Configuration examples

How you decide which modes to use in your solution is an exercise in matching the
requirements of your system, and selecting which modules are needed during each mode
of the operation for your application. The best way to explain would be to work through
an example.

For example, consider the case of a battery-operated human interface device that requires
an LPTMR timebase. It will wake up periodically and check the conditions of several
sensors. Then it will take action based upon the state and, when requested, perform high
levels of computation to control the operation of a device. After reviewing the power
modes table in Module operation in low-power modes, you should be able to identify
which of the modules are functioning in each of the low-power modes.
At this point, notice that the LPTMR, and optionally, the brown-out detection, are the only modules that are fully functional in all of the lowest power modules. Notice also the modules that allow wake-up in the low-power modes such as the GPIO, LLWU, or the comparator.

In this example system, the MCU spends most of the time in one of the lower power modes waking up periodically to check sensor signals, plus other house-keeping tasks.

The MCU also wakes up from a user input. This can be hitting a button, a touch of a capacitive sensor, the rise or fall of an analog signal from a sensor feeding the comparator. To enable these sources please refer to the LLWU section 3 in the device-specific reference manual for configuration details.

The example drivers code for SMC are available from the Freescale Web site www.freescale.com.

Please refer to AN4503 for power management ideas and explanations as well as mode entry and exit drivers.

### 5.3.2.1 SMC code example and explanation

There are four registers in the system mode controller:

- **PMPROT**: Power Management Protection
- **PMCTRL**: controls entry into low-power run and stop modes
- **STOPCTRL**: provides various control bits enabling the user to fine tune power consumption during the stop mode
- **PMSTAT**: a read-only register that indicates the current power mode of the system

PMPROT is a write once register after a reset. This means that when written, all subsequent writes are ignored. In our example system above, our two basic modes of operation are Run mode and VLPS mode. If we do not want the MCU to be in any other low-power mode, we would want to write the AVLP bit in the PMPROT register.

```
SMC -> PMPROT = SMC_PMPROT_AVLP_MASK;
```

This write allows the MCU to enter WAIT, Normal STOP or VLPS only. It is then no longer possible to enter any other low-power mode.

After the PMPROT register has been written, the write to PMCTRL and STOPCTRL determines the mode that will be entered. For our example, entry into VLPS mode would be enabled with this write sequence.

```
SMC -> PMCTRL &= ~SMC_PMCTRL_STOPM_MASK;
SMC -> PMCTRL |= SMC_PMCTRL_STOPM(0x02);
```
5.3.2.1.1 Mode entry sequence serialization

To ensure that the correct mode is entered there are some serialization considerations. This means that the write to PMCTRL takes 6-7 cycles to complete and if the write to PMCTRL is done immediately before the WFI instruction is executed, see the bad code below, then the MCU may try to enter the mode that was defined before the write was made.

//BAD CODE//
/* Set the SLEEPDEEP bit to enable deep sleep mode (STOP) */
SCB -> SCR |= SCB_SCR_SLEEPDEEP_MASK;
SMC -> PMCTRL |= ~SMC_PMCTRL_STOPM(0x2);
/* if PMCTRL register was previously a 0x00 before the write,
the low power mode entered with the execution of next
instruction WFI may be NORMAL STOP not VLPS */
asm("WFI");

If you need to change the mode control value of STOPM right before entering the low-power mode, then it is best to do a read back of the PMCTRL register before executing the WFI. This insures the write has completed before the core starts the low-power mode entry. See the updated serialized code sequence below. To make sure the read does not get optimized out by the compiler define as volatile.

// BETTER CODE //
volatile unsigned int dummyread;
/* Set the SLEEPDEEP bit to enable deep sleep mode (STOP) */
SCB -> SCR |= SCB_SCR_SLEEPDEEP_MASK;
SMC -> PMCTRL |= ~SMC_PMCTRL_STOPM(0x2);
dummyread = SMC -> PMCTRL;
asm("WFI");

5.3.2.2 Entering wait mode

If you want to use WAIT mode, then the SLEEPDEEP bit needs to be cleared before executing the WFI instruction.

SCB -> SCR &= ~SCB_SCR_SLEEPDEEP_MASK;

5.3.2.3 Exiting low-power modes

Each of the power modes has a specific list of exit methods. Mode exit from low power modes WAIT, VLPW, STOP, and VLPS are initiated by an interrupt. Mode exit from VLLSx is from the LLWU enabled wake-up source. These exit methods are discussed later.
Recovery from VLLSx is through the wake-up reset event. The MCU will wake from VLLSx by means of reset, an enabled pin, or an enabled module. See Table 5-3 in the LLWU configuration section for a list of the sources. The wake-up flow from VLLS0, VLLS1, and VLLS3 is through reset. The wake-up bit in the SRS registers is set, indicating that the MCU is recovering from a low power mode. Code execution begins but the I/O are held in the pre-low-power mode entry state and the oscillator is disabled even if EREFSTEN had been set before entering VLLSx. The user is required to clear this hold by writing to PMC_REGSC[ACKISO].

Prior to releasing the hold the user must reinitialize the I/O to the pre-low-power mode entry state, so that unwanted transitions on the I/O do not occur when the hold is released.

5.4 Using the low leakage wakeup unit

5.4.1 Overview

This section will demonstrate how to use the Low Leakage Wake-up Unit (LLWU). The LLWU is responsible for selecting and enabling the sources of exit from VLLS3, VLLS1, and VLLS0 low-power modes of the MCU. This module works in conjunction with the PMC and the MCU to wake-up the MCU.

5.4.1.1 Mode transitions

There are particular requirements for exiting form each of the power modes. Please see Mode transition requirements for a table of the transition requirements for each of the modes of operation.

5.4.1.2 Wake-up sources

There are a possible 16 pin sources and up to 8 modules available as sources of wake-up. Please see Source of wake-up, pins, and modules for a table of external pin wake-up and module wake-up sources.
5.4.2 LLWU configuration examples

There are 8-bit wake-up source enable registers for the pin and module source selection. There are 8-bit wake-up flag registers to indicate which wake-up source was triggered, 8-bit flag register and 8-bit filter control register to control the digital filter enable for up to two external pins.

5.4.2.1 Enabling pins and modules in the LLWU

With Kinetis V series devices the LLWU wakeup pins are identified and numbered to be compatible with the K series MCUs. LLWU pins range from LLWU_P3 to LLWU_P15 but are not contiguous.

5.4.2.2 Module wake-up

To configure a module to wake-up the MCU from one of the low-power modes requires a study in the control and function of each of the modules capable of waking the MCU. Because the LPTMR can be on in all low-power mode, we can configure the LPTMR to wake up the system when its interrupt flag is set. To do this we need to enable the LPTMR module to cause an interrupt and then allow that interrupt to cause a wake-up. To enable the LPTMR to cause a wake-up the corresponding module wake-up bit must be set.

```c
LLWU -> ME = LLWU_ME_WUME0_MASK;
       // enable the LPTMR overflow to wake up from low power modes
```

Other modules have to be enabled in the same way.

5.4.2.3 Pin wake-up

To configure a pin to wake-up the MCU from the low-power modes requires a study of the port configuration register controls and the GPIO functionality.

The PCR registers select the multiplex selection, the pull enable function, and the interrupt edge selection. If we want to initialize the first wake-up pin, PTE1, as an LLWU wake-up enabled pin we need to:

1. Initialize the PCR for PTD6.
2. Make sure the pin is an input.
3. Enable PTD6 as a valid wake-up source in the LLWU.
The code below configures a pin as a GPIO input pin. It can be a LLWU wake-up as long as it is selected as a digital input pin.

```c
/* Enable Port D6 to be a digital pin. */
SIM -> SCGC5 = SIM_SCGC5_PORTD_MASK;
PORTD -> PCR6 = (PORT_PCR_ISF_MASK |    //  clear Flag if there
PORT_PCR_MUX(01) |    //  GPIO
PORT_PCRIRQC(0x0A) |  //  falling= A Rising = 9
PORT_PCRPE_MASK |     //  Pull enable
PORT_PCRPS_MASK);     //  pull up/down enable
GPIOD -> PDDR &= 0xFFFFFFBF;            //  set Port D6 as input

/* Set the LLWU pin enable bits to enable the PORTD6 input
* to be a wakeup source.
* WUPE15 in the LLWU_PE4 register is used in this case
* since it is associated with PTD6. */
LLWU -> PE4 = LLWU_PE4_WUPE15(2); //falling edge detection
```

This needs to be done for each of the pins you want to enable as an interrupt and low leakage mode wake-up source.

### 5.4.2.4 LLWU port and module interrupts

In low-power modes the ARM core is off, the NVIC is off some of the time, and the WIC is kept alive allowing an interrupt from the pin or module to propagate to the mode controller to indicate a wake-up request. To enable the LLWU interrupt we would initialize the LLWU vector in the interrupt vector table with the appropriate LLWU interrupt handler with the following sequence:

```c
/* example code - in the isr.h file */
#define VECTOR_023 LLWU_Isr
#define VECTOR_047 PortBCDE_Isr

/* example code in the interrupt vectors initialization code */
NVIC_EnableIRQ(LLWU_IRQn);         // ready for this interrupt.
NVIC_EnableIRQ(PORTBCDE_IRQn); // ready for this interrupt.
```

Then, there is a need for interrupt service routines for the two enabled interrupt sources, the LLWU interrupt, and the port BCDE interrupt.

### 5.4.2.5 Wake-up sequence

The wake-up sequence is not obvious for some of the modes. For most of the wait and stop modes code execution follows a predictable flow.
For VLLS0, VLLS1, or VLLS3, the exit is always through the reset vector and then through the interrupt vector of the LLWU immediately after the LLWU interrupt is enabled in the NVIC with the "NVIC_EnableIRQ(LLWU_IRQHandler)" function call. There is a WAKEUP bit in the RCM_SRS0 register that allows the user to tell if the reset was due to an LLWU wake-up event.

An example of wake-up test code is shown below:

```c
if (RCM -> SRS0 & RCM_SRS0_WAKEUP_MASK) {
    printf("Wakeup bit set from low power mode ");
    if (((SMC -> PMCTRL & SMC_PMCTRL_STOPM_MASK)== 4) &&
        ((SMC -> STOPCTRL & SMC_STOPCTRL_VLLSM_MASK)== 0))
        printf("VLLS0 exit ");
    if (((SMC -> PMCTRL & SMC_PMCTRL_STOPM_MASK)== 4) &&
        ((SMC -> STOPCTRL & SMC_STOPCTRL_VLLSM_MASK)== 1))
        printf("VLLS1 exit ");
    if (((SMC -> PMCTRL & SMC_PMCTRL_STOPM_MASK)== 4) &&
        ((SMC -> STOPCTRL & SMC_STOPCTRL_VLLSM_MASK)== 2))
        printf("VLLS2 exit ");
    if (((SMC -> PMCTRL & SMC_PMCTRL_STOPM_MASK)== 4) &&
        ((SMC -> STOPCTRL & SMC_STOPCTRL_VLLSM_MASK)== 3))
        printf("VLLS3 exit ");
}
```

If the LPTMR is the wake-up source and the LLWU interrupt is enabled in sequence before the LPTMR interrupts you must clear the source of the module interrupt or else the code execution will never leave the LLWU interrupt service routine. An example is given in the code snippet below:

```c
if (LLWU -> F3 & LLWU_F3_MWUF0_MASK) {
    SIM -> SCGC5 |= SIM_SCGC5_LPTMR_MASK;
    LPTMR0 -> CSR |= LPTMR_CSR_TCF_MASK;
    // write 1 to TCF to clear the LPT timer compare flag
    LPTMR0 -> CSR = ( LPTMR_CSR_TEN_MASK
                    | LPTMR_CSR_TIE_MASK
                    | LPTMR_CSR_TCF_MASK );
    // write one to clear the flag
    LLWU -> F3 |= LLWU_F3_MWUF0_MASK;
}
```

The I/O states and the oscillator setup are held if the wake-up event is from VLLS0, VLLS1, or VLLS3. The user is required to clear this hold by writing to the ACKISO bit in the PMC_REGSC register. Prior to releasing the hold the user must reinitialize the I/O to the pre-low-power mode entry state, so that unwanted transitions on the I/O do not occur when the hold is released.

```c
if (PMC -> REGSC &  PMC_REGSC_ACKISO_MASK)
    PMC -> REGSC |= PMC_REGSC_ACKISO_MASK;
```
### 5.5 Module operation in low-power modes

Table 5-1. Module operation in low power modes

<table>
<thead>
<tr>
<th>Modules</th>
<th>VLPR</th>
<th>VLPW</th>
<th>Stop</th>
<th>VLPS</th>
<th>VLLSx</th>
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<tbody>
<tr>
<td><strong>Core modules</strong></td>
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<tr>
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</tr>
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<td>Mode Controller</td>
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<td>FF</td>
<td>FF</td>
<td>FF</td>
<td>FF</td>
</tr>
<tr>
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<td>static</td>
<td>static</td>
<td>static</td>
<td>static</td>
<td>FF(^2)</td>
</tr>
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<td>Regulator</td>
<td>low power</td>
<td>low power</td>
<td>ON</td>
<td>low power</td>
<td>low power in VLLS3, OFF in VLLS0/1</td>
</tr>
<tr>
<td>LVD</td>
<td>disabled</td>
<td>disabled</td>
<td>ON</td>
<td>disabled</td>
<td>disabled</td>
</tr>
<tr>
<td>Brown-out Detection</td>
<td>ON</td>
<td>ON</td>
<td>ON</td>
<td>ON</td>
<td>ON in VLLS1/3, optionally disabled in VLLS0(^3)</td>
</tr>
<tr>
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<td>FF</td>
<td>FF</td>
<td>Async operation</td>
<td>Async operation</td>
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</tr>
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<td>FF</td>
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#### Clocks

<table>
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<tr>
<th></th>
<th>1kHz LPO</th>
<th></th>
<th></th>
<th></th>
<th></th>
</tr>
</thead>
<tbody>
<tr>
<td>System oscillator (OSC)</td>
<td>OSCERCLK max of 16 MHz crystal</td>
<td>OSCERCLK max of 16 MHz crystal</td>
<td>OSCERCLK optional</td>
<td>OSCERCLK max of 16 MHz crystal</td>
<td>limited to low range/low power in VLLS1/3, OFF in VLLS0</td>
</tr>
<tr>
<td>MCG</td>
<td>4 MHz IRC</td>
<td>4 MHz IRC</td>
<td>static - MCGIRCLK optional</td>
<td>static - MCGIRCLK optional</td>
<td>OFF</td>
</tr>
<tr>
<td>Core clock</td>
<td>4 MHz max</td>
<td>OFF</td>
<td>OFF</td>
<td>OFF</td>
<td>OFF</td>
</tr>
<tr>
<td>Platform clock</td>
<td>4 MHz max</td>
<td>4 MHz max</td>
<td>OFF</td>
<td>OFF</td>
<td>OFF</td>
</tr>
<tr>
<td>System clock</td>
<td>4 MHz max</td>
<td>OFF in CPO</td>
<td>OFF</td>
<td>OFF</td>
<td>OFF</td>
</tr>
<tr>
<td>Bus clock</td>
<td>1 MHz max</td>
<td>OFF in CPO</td>
<td>OFF</td>
<td>OFF</td>
<td>OFF</td>
</tr>
</tbody>
</table>

#### Memory and memory interfaces

Table continues on the next page...
<table>
<thead>
<tr>
<th>Modules</th>
<th>VLPR</th>
<th>VLPW</th>
<th>Stop</th>
<th>VLPS</th>
<th>VLLSx</th>
</tr>
</thead>
<tbody>
<tr>
<td>Flash</td>
<td>1 MHz max access</td>
<td>low power</td>
<td>low power</td>
<td>low power</td>
<td>OFF</td>
</tr>
<tr>
<td></td>
<td>- no program</td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td></td>
<td>No register access</td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td></td>
<td>in CPO</td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>SRAM</td>
<td>low power</td>
<td>low power</td>
<td>low power</td>
<td>low power</td>
<td>low power in</td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td>VLLS3, OFF in</td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td>VLLS0/1</td>
</tr>
</tbody>
</table>

**Communication interfaces**

| UART0     | 1 Mbit/s                  | 1 Mbit/s | static | static | OFF            |
|           | Async operation in CPO    | static | static | static | OFF            |
| UART1     | 1 Mbit/s                  | 1 Mbit/s | Async operation | Async operation | OFF |
|           | Async operation in CPO    | static | static | static | OFF            |
| SPI0      | master mode 500 kbit/s    | master mode 500 kbit/s | static | static | OFF            |
|           | slave mode 250 kbit/s     | slave mode 250 kbit/s | static | static | OFF            |
|           | static, slave mode receive in CPO | static | static | static | OFF            |
| I²C0      | 50 kbit/s                 | 50 kbit/s | static, address match wakeup | static, address match wakeup | OFF |
|           | static, address match wakeup in CPO | static | static | static | OFF            |

**Timers**

| FTM0, FTM1, FTM2 | FF | FF | static | static | OFF |
| PDB              | FF | FF | static | static | OFF |
| LPTMR            | FF | FF | Async operation | Async operation | Async operation |

**Analog**

| 16-bit ADC       | FF | FF | ADC internal clock only | ADC internal clock only | OFF |
|                  | ADC internal clock only in CPO | static | static | static | OFF |
| CMP<sup>5</sup>  | FF | FF | HS or LS compare FF in PSTOP2 | HS or LS compare FF in PSTOP2 | LS compare in VLLS1/3, OFF in VLLS0 |
| 6-bit DAC        | FF | FF | static | static | static |
|                  | static in CPO | static | static | static | static |
| 12-bit DAC       | FF | FF | static | static | static |

*Table continues on the next page...*
### Table 5-1. Module operation in low power modes (continued)

<table>
<thead>
<tr>
<th>Modules</th>
<th>VLPR</th>
<th>VLPW</th>
<th>Stop</th>
<th>VLPS</th>
<th>VLLSx</th>
</tr>
</thead>
<tbody>
<tr>
<td></td>
<td>static in CPO</td>
<td>FF in PSTOP2</td>
<td></td>
<td></td>
<td>OFF, pins latched</td>
</tr>
</tbody>
</table>

### Human-machine interfaces

<table>
<thead>
<tr>
<th>GPIO</th>
<th>FF</th>
<th>FF</th>
<th>static output, wakeup input</th>
<th>static output, wakeup input</th>
<th>OFF, pins latched</th>
</tr>
</thead>
<tbody>
<tr>
<td>IOPORT write only in CPO</td>
<td></td>
<td></td>
<td>FF in PSTOP2</td>
<td></td>
<td></td>
</tr>
</tbody>
</table>

1. Using the LLWU module, the external pins available for this chip do not require the associated peripheral function to be enabled. It only requires the function controlling the pin (GPIO or peripheral) to be configured as an input to allow a transition to occur to the LLWU.

2. Since LPO clock source is disabled, filters will be bypassed during VLLS0.

3. The STOPCTRL[PORPS] bit in the SMC module controls this option.

4. LPO clock source is not available in VLLS0. To use system OSC in VLLS0 it must be configured for bypass (external clock) operation. Pulse counting is available in all modes.

5. CMP in stop or VLPS supports high speed or low speed external pin-to-pin or external pin-to-DAC compares. CMP in VLLSx only supports low speed external pin-to-pin or external pin-to-DAC compares. Windowed, sampled & filtered modes of operation are not available while in stop, VLPS, or VLLSx modes.

### 5.6 Mode transition requirements

The following table defines triggers for the various state transitions:

#### Table 5-2. Power mode transition triggers

<table>
<thead>
<tr>
<th>Transition #</th>
<th>From</th>
<th>To</th>
<th>Trigger conditions</th>
</tr>
</thead>
<tbody>
<tr>
<td>1</td>
<td>RUN</td>
<td>WAIT</td>
<td>Sleep-now or sleep-on-exit modes entered with SLEEPDEEP clear, controlled in System Control Register in ARM core.</td>
</tr>
<tr>
<td></td>
<td>WAIT</td>
<td>RUN</td>
<td>Interrupt or Reset</td>
</tr>
<tr>
<td>2</td>
<td>RUN</td>
<td>STOP</td>
<td>Sleep-now or sleep-on-exit modes entered with SLEEPDEEP set, which is controlled in System Control Register in ARM core.</td>
</tr>
<tr>
<td></td>
<td>STOP</td>
<td>RUN</td>
<td>Interrupt or Reset</td>
</tr>
<tr>
<td>3</td>
<td>RUN</td>
<td>VLPR</td>
<td>The core, system, bus and flash clock frequencies are restricted in this mode. Set PMPROT[AVLP]=1, PMCTRL[RUNM]=10</td>
</tr>
<tr>
<td></td>
<td>VLPR</td>
<td>RUN</td>
<td>Set PMCTRL[RUNM]=00 or Reset.</td>
</tr>
<tr>
<td>4</td>
<td>VLPR</td>
<td>VLPW</td>
<td>Sleep-now or sleep-on-exit modes entered with SLEEPDEEP clear, which is controlled in System Control Register in ARM core.</td>
</tr>
<tr>
<td></td>
<td>VLPW</td>
<td>VLPR</td>
<td>Interrupt</td>
</tr>
<tr>
<td>5</td>
<td>VLPW</td>
<td>RUN</td>
<td>Reset.</td>
</tr>
</tbody>
</table>

Table continues on the next page...
Table 5-2. Power mode transition triggers (continued)

<table>
<thead>
<tr>
<th>Transition #</th>
<th>From</th>
<th>To</th>
<th>Trigger conditions</th>
</tr>
</thead>
<tbody>
<tr>
<td>6</td>
<td>VLPR</td>
<td>VLPS</td>
<td>PMCTRL[STOPM]=000</td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td>and STOPCTRL[PSTOPO]=00, then VLPS mode is entered</td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td>instead of STOP. If PMCTRL[STOPM]=000 and</td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td>STOPCTRL[PSTOPO]=01 or 10, then only a Partial Stop</td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td>mode is entered instead of VLPS or 010,</td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td>Sleep-now or sleep-on-exit modes entered with SLEEPDEEP</td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td>set, which is controlled in System Control Register in ARM</td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td>core.</td>
</tr>
<tr>
<td></td>
<td>VLPS</td>
<td>VLPR</td>
<td>Interrupt</td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td>NOTE: If VLPS was entered directly from RUN, hardware</td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td>will not allow this transition and will force exit back to</td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td>RUN</td>
</tr>
<tr>
<td>7</td>
<td>RUN</td>
<td>VLPS</td>
<td>PMPROT[AVLP]=1, PMCTRL[STOPM]=010,</td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td>Sleep-now or sleep-on-exit modes entered with SLEEPDEEP</td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td>set, which is controlled in System Control Register in ARM</td>
</tr>
<tr>
<td></td>
<td>VLPS</td>
<td>RUN</td>
<td>Interrupt and set PMCTRL[RUNM]=00, transitioning to RUN</td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td>before entering VLPS or</td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td>Reset.</td>
</tr>
<tr>
<td>8</td>
<td>RUN</td>
<td>VLLSx</td>
<td>PMPROT[AVLLS]=1, PMCTRL[STOPM]=100,</td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td>STOPCTRL[VLLSM]=x (VLLSx), Sleep-now or sleep-on-exit</td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td>modes entered with SLEEPDEEP set, which is controlled in</td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td>System Control Register in ARM core.</td>
</tr>
<tr>
<td></td>
<td>VLLSx</td>
<td>RUN</td>
<td>Wake up from enabled LLWU LPTMR input source or RESET</td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td>pin</td>
</tr>
<tr>
<td>9</td>
<td>VLPR</td>
<td>VLLSx</td>
<td>PMPROT[AVLLS]=1, PMCTRL[STOPM]=100,</td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td>STOPCTRL[VLLSM]=x (VLLSx), Sleep-now or sleep-on-exit</td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td>modes entered with SLEEPDEEP set, which is controlled in</td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td>System Control Register in ARM core.</td>
</tr>
</tbody>
</table>

5.7 Source of wake-up, pins, and modules

Table 5-3. Source of wake-up, pins, and modules

<table>
<thead>
<tr>
<th>LLWU pin</th>
<th>Module source or pin name</th>
</tr>
</thead>
<tbody>
<tr>
<td>LLWU_P3</td>
<td>PTA4</td>
</tr>
<tr>
<td>LLWU_P5</td>
<td>PTB0</td>
</tr>
<tr>
<td>LLWU_P6</td>
<td>PTC1</td>
</tr>
<tr>
<td>LLWU_P7</td>
<td>PTC3</td>
</tr>
<tr>
<td>LLWU_P8</td>
<td>PTC4</td>
</tr>
<tr>
<td>LLWU_P9</td>
<td>PTC5</td>
</tr>
<tr>
<td>LLWU_P10</td>
<td>PTC6</td>
</tr>
<tr>
<td>LLWU_P12</td>
<td>PTD0</td>
</tr>
</tbody>
</table>

Table continues on the next page...
Table 5-3. Source of wake-up, pins, and modules (continued)

<table>
<thead>
<tr>
<th>LLWU pin</th>
<th>Module source or pin name</th>
</tr>
</thead>
<tbody>
<tr>
<td>LLWU_P13</td>
<td>PTD2</td>
</tr>
<tr>
<td>LLWU_P14</td>
<td>PTD4</td>
</tr>
<tr>
<td>LLWU_P15</td>
<td>PTD6</td>
</tr>
<tr>
<td>LLWU_M0IF</td>
<td>LPTMR0</td>
</tr>
<tr>
<td>LLWU_M1IF</td>
<td>CMP0</td>
</tr>
<tr>
<td>LLWU_M2IF</td>
<td>CMP1</td>
</tr>
<tr>
<td>LLWU_M3IF</td>
<td>Reserved</td>
</tr>
<tr>
<td>LLWU_M4IF</td>
<td>Reserved</td>
</tr>
<tr>
<td>LLWU_M5IF</td>
<td>Reserved</td>
</tr>
<tr>
<td>LLWU_M6IF</td>
<td>Reserved</td>
</tr>
<tr>
<td>LLWU_M7IF</td>
<td>Reserved</td>
</tr>
</tbody>
</table>
Chapter 6
enhanced Direct Memory Access (eDMA) Controller

6.1 eDMA

6.1.1 Overview

This chapter is a compilation of code examples and quick reference materials created to shorten the development time of your applications that use the eDMA controller of the Kinetis V series. Consult the device-specific reference manual for specific part information.

This chapter demonstrates how to configure and use the eDMA controller to create data movement between different memory and peripheral spaces without CPU intervention.

6.1.2 Introduction

The eDMA controller provides the ability to move data from one memory mapped location to another. After it is configured and initiated, the eDMA controller operates in parallel to the core, performing data transfers that would otherwise have been handled by the CPU. This results in reduced CPU loading and a corresponding increase in system performance. Figure 6-1 illustrates the functionality provided by the eDMA controller.
The eDMA controller contains a 16-bit data buffer as temporary storage. Because the Kinetis V series is a crossbar based architecture, the CPU is the primary bus master connected to the M0 master port. The eDMA is connected to the M2 master port of the crossbar switch. Therefore, the CPU and eDMA can access different slave ports simultaneously. With this multi-master architecture, the system can maximize the use of the eDMA features. Figure 6-2 shows the basic architecture of the Kinetis V series. A specialized device may have differences—refer to the device-specific reference manual for details.
The crossbar switch forms the heart of this multi-master architecture. It links each master to the required slave device. Both fixed priority and round robin arbitration schemes are available. If both masters attempt joint access to the same slave, an arbitration scheme begins and eliminates bus contention.

### 6.2 eDMA trigger

Each channel of the Kinetis eDMA controller can be configured to begin DMA transfers from multiple peripheral sources or software. The eDMA controller integrates the DMA Mux to route a different trigger source to the 16 channels. With the DMA Mux, up to 63 events occurring within other peripheral modules can activate an eDMA transfer. In many modules, event flags can be asserted as either eDMA or Interrupt requests. These sources can be selected through DMAMUX_CHCFGn[SOURCE] registers. However, different devices may have different peripheral source configurations. Refer to the device-specific reference manual for details.

#### 6.2.1 DMA multiplexer

The eDMA channel multiplexer routes the eDMA trigger source. The 52 peripheral slots and 10 always-on slots can be routed to the 16 channels. Each channel router can be assigned to one of the 52 possible peripheral DMA slots or to one of the 10 always-on slots.
6.2.2 Trigger mode

The eDMA multiplexer supports two options to trigger eDMA transfer requests.

- **Disabled mode**—No request signal is routed to the channel and the channel is disabled. This is the reset state of a channel in DMA MUX. Disabled mode can also be used to suspend a DMA channel while it is reconfigured or not required.
- **Normal mode**—A DMA request is routed directly to the specified eDMA channel.
6.2.3 Multiple transfer requests

Only one channel can actively perform a transfer. To manage multiple pending transfer requests, the eDMA controller offers channel prioritization. Fixed priority or round robin priority can be selected.

In the fixed priority scheme each channel is assigned a priority level. When multiple requests are pending, the channel with the highest priority level performs its transfer first. By default, fixed priority arbitration is implemented with each channel being assigned a priority level equal to its channel number. Higher priority channels can preempt lower priority channels. Preemption occurs when a channel is performing a transfer while a transfer request is asserted to a channel of a higher priority. The lower priority channel halts its transfer on completion of the current read/write operation and enables the channel of higher priority to work.

In round robin mode, the eDMA cycles through the channels from the highest to the lowest, checking for a pending request. When a channel with a pending request is reached, it is allowed to perform its transfer. After the transfer has been completed, the eDMA continues to cycle through the channels looking for the next pending request.

6.3 Transfer process

Each channel requires a 32-byte transfer control descriptor (TCD) for defining the desired data movement operation. The channel descriptors are stored in the eDMA local memory in sequential order.

Each time a channel is activated and executes, n bytes are transferred from the source to the destination. This is referred to as a minor transfer loop. A major transfer loop consists of a number of minor transfer loops, and this number is specified within the TCD. As iterations of the minor loop are completed, the current iteration (CITER) TCD field is decremented. When the current iteration field has been exhausted, the channel has completed a major transfer loop. This figure shows the relationship between major and minor loops. In this example a channel is configured so that a major loop consists of three iterations of a minor loop. The minor loop is configured as a transfer of 4 bytes.
6.4 Configuration steps

To configure the eDMA, the following initialization steps must be followed:

1. Write the eDMA control register (only necessary when other than the default configuration is required).
2. Configure channel priority registers in the DCHPRIn (as required).
3. Enable error interrupts using either the DMAEEI or DMASEEI register (as required).
4. Write the transfer control descriptors for the channels that will be used.
5. Configure the appropriate peripheral module and configure the eDMA MUX to route the activation signal to the appropriate channel.

All transfer attributes for a channel are defined in the unique TCD for the channel. Each 32-bit TCD is stored in the eDMA controller module. Only the DONE, ACTIVE and STATUS fields are initialized at reset. All other TCD fields are undefined at reset and must be initialized by the software before the channel is activated. Failure to do this results in unpredictable behavior. Refer to the device-specific reference manual for the TCD detail description.

6.5 Example—ADC scan multiple channels

In this example, the eDMA is used to supply the analog-to-digital converter with a command word and move the result of AD to a location in the internal SRAM. The AD command word stores all the information that the AD module requires for a conversion, so by using the eDMA to provide the command words, the module can be instructed to perform conversions without any CPU intervention. After the result is transferred by the eDMA to internal SRAM, the application can make further analysis on the data.
6.5.1 Module configuration

To implement this example two eDMA channels are required: one to transfer the command word and the other to transfer the result. The command transfer requests a software trigger by setting the START bit of channel 1, and an always-on trigger. Channel 1 is configured to perform this transfer.

Channel 0 is used to transfer the AD result to RAM. This transfer is activated when the AD result ready flag is asserted, and after transfer is complete. Link to channel0 to transfer the next command to the ADC SC1 register, until all channels complete conversion and BITER counter is equal to 0, generate eDMA interrupt request.

The following code provides the eDMA driver and defines the eDMA structure to complete the configuration.

```c
sDMAConfig.Channel = 1;
sDMAConfig.Slot = DMA_SLOTS_ALWAYS_EN;  /* always on */
sDMAConfig.sSetting.bIntEn = TRUE;
sDMAConfig.sSetting.bDebugEn = TRUE;
sDMAConfig.sSetting.bRoundRobinEn = TRUE;
sDMAConfig.sSetting.bReqEn = FALSE;

sTCDInfo.SADDR = (uint32_t)&u32ADCChannel[0];
sTCDInfo.SOFF = sizeof(u32ADCChannel[0]);
sTCDInfo.ATTR = DMA_ATTR_SMOD(0) |
                DMA_ATTR_SSIZE(2) |
                DMA_ATTR_DSIZE(2) |
                DMA_ATTR_DMOD(0);

sTCDInfo.NBYTES_MLNO = sizeof(u32ADCChannel[0]);
sTCDInfo.DADDR = (uint32_t)&ADC0->SC1[0];
sTCDInfo.DOFF = 0;
sTCDInfo.BITER_ELINKNO= DMA_BITER_ELINKYES_BITER(ADC_CHANNEL_NUMBERS)
sTCDInfo.CITER_ELINKNO = sTCDInfo.BITER_ELINKNO;
sTCDInfo.SLAST = -(sizeof(u32ADCChannel[0])*ADC_CHANNEL_NUMBERS);
sTCDInfo.CSR = DMA_CSR_INTMAJOR_MASK;
sDMAConfig.sTCDInfo = sTCDInfo;
/* Initialize the eDMA channel1 to transfer channel value to ADC_SC1 */
DMA_Init(DMA0,&sDMAConfig);

sDMAConfig.Channel = 0;
sDMAConfig.Slot = DMA_SLOTS_ADC0;  /* ADC0 request */
sDMAConfig.sSetting.bReqEn = TRUE;

sTCDInfo1.SADDR = (uint32_t)&ADC0->R[0];
sTCDInfo1.SOFF = 0;
sTCDInfo1.ATTR = DMA_ATTR_SMOD(0) |
                DMA_ATTR_SSIZE(2) |
                DMA_ATTR_DSIZE(2) |
                DMA_ATTR_DMOD(0);

sTCDInfo1.NBYTES_MLNO = sizeof(u32ADCResult[0]);
sTCDInfo1.DADDR = (uint32_t)&u32ADCResult[0];
sTCDInfo1.DOFF = sizeof(u32ADCResult[0]);
sTCDInfo1.BITER_ELINKYES = DMA_BITER_ELINKYES_BITER(ADC_CHANNEL_NUMBERS)
                         |DMA_BITER_ELINKYES_ELINK_M(ADC_CHANNEL_NUMBERS) |
                         |DMA_BITER_ELINKYES_LINKCH(1) ;
```
Example—ADC scan multiple channels

    sTCDInfo1.CITER_ELINKYES = sTCDInfo1.BITER_ELINKYES;
    sTCDInfo1.DLAST_SGA = -(sizeof(u32ADCResult[0])*ADC_CHANNEL_NUMBERS);
    sTCDInfo1.CSR = DMA_CSR_INTMAJOR_MASK;
    sDMAConfig.sTCDInfo = sTCDInfo1;
    /* Initialize the eDMA channel0 to transfer ADC result to buffer */
    DMA_Init(DMA0,&sDMAConfig);
    DMA_SetCallBack(DMA_Ch0Task,0);
    NVIC_EnableIRQ(DMA0_IRQn);
    DMA_SetCallBack(DMA_Ch1Task,1);
    NVIC_EnableIRQ(DMA1_IRQn);

    /* Set eDMA channel 0 "START" bit, launch ADC conversion */
    DMA_SetSTARTbit(DMA0,0x1);

Using the above configurations, the required DMA functionality for this example has
been achieved.
Chapter 7
Universal Asynchronous Receiver and Transmitter (UART) Module

7.1 Overview

The UART module on the Kinetis V series devices supports asynchronous, full-duplex serial communications with peripheral devices or other CPUs. The UART module has four main modes of operation -- UART, IrDA, and LIN mode.

The following sections will discuss the features and use of the UART in UART mode. In particular the use of the UART as an RS-232 serial communication port will be described. For full details on the UART module, including all of its features and modes of operation, please see the device-specific reference manual.

7.2 Features

The feature set available on the UARTs vary from UART to UART. Basic UART functionality is available on all UARTs, but the clock source for the module and the transmit and receive FIFO sizes can vary. The UART instantiation table lists the UART features that vary based on UART module instantiation.

<table>
<thead>
<tr>
<th>UART instance</th>
<th>LIN supported?</th>
<th>FIFOs</th>
<th>Module clock</th>
</tr>
</thead>
<tbody>
<tr>
<td>UART0</td>
<td>Yes</td>
<td>8 entry TxFIFO, 8 entry RxFIFO</td>
<td>Core clock</td>
</tr>
<tr>
<td>UART1</td>
<td>Yes</td>
<td>8 entry TxFIFO, 8 entry RxFIFO</td>
<td>Peripheral clock</td>
</tr>
</tbody>
</table>

NOTE
This table describes the UART instantiations on the Kinetis V series devices available at the time of publication. As new
Kinetis devices become available the UART instantiations might change. See the *Chip Configuration* chapter of the device-specific reference manual to verify the UART instantiation information for your device.

### 7.3 Configuration example

The examples included here poll UART status flags to determine when receive data is available or when transmit data can be written into the FIFO. This approach is the most CPU intensive, but it is often the most practical approach when handling small messages. As message sizes increase it might be useful to use interrupts or the eDMA to decrease the CPU loading. However, the overhead required to set up the interrupts or eDMA must be taken into account. If the additional overhead outweighs the reduction in CPU loading, then polling is the best approach.

Using the UART interrupts to signal the CPU that data can be read from or written to the UART will help to decrease the CPU loading. The UART has a number of status and error interrupt flags that can be used, but for typical receive and transmit operations the receive data register full flag (UARTx_S1[RDRF]) and transmit data register empty flag (UARTx_S1[TDRE]) are enabled using the UARTx_C2[TIE, RIE] bits. The names of these flags are misleading, because they do not always indicate a full or empty condition. For UARTs that include a FIFO, the full or empty condition is determined based on the amount of data in the FIFO compared to a programmable watermark. If both the RDRF and TDRE interrupt requests are enabled, then the UART interrupt handler needs to read the S1 register to determine which condition is true then read and/or write to the UART data register (UARTx_D) to clear the flags. Because the CPU is responsible for moving data there is CPU loading associated with an interrupt-driven software approach.

Using the eDMA to move data minimizes CPU loading even more than using the UART interrupts. The UART's same RDRF and TDRE flags used for an interrupt driven software approach can be re-routed to the eDMA controller instead. This is done by setting the UARTx_C5[TDMAS, RDMAS] bits. Each of these requests are routed to a different eDMA channel (the specific eDMA channels are selected by programming the eDMA channel mux). One eDMA channel is responsible for handling receive traffic, so it reads one or more bytes from the UART for each request. The second eDMA channel is responsible for handling the transmit traffic, so it writes one or more bytes to the UART for each request. When the entire transmit or receive eDMA movement is complete the eDMA can interrupt the core to notify it of the completion. In this approach the CPU has no loading associated with the actual data movement. All of the CPU loading is the result
of the initial configuration of both the UART and eDMA modules and then any processing of data that is required to prepare it for transmission or interpret it after reception.

7.3.1 UART initialization example

The initialization code provided in this section can be used to configure the UART for 8-N-1 operation (eight data bits, no parity, and one stop bit) with interrupts and hardware flow-control disabled. The parameters passed into this function are the UART channels to initialize (uartch), the module clock frequency for the UART in kHz (sysclk), and the desired baud rate for communication (baud).

NOTE
The UART modules are pinned out in multiple locations, so the initialization function below doesn't know which UART pins to enable. The desired UART pins should be enabled before calling this initialization function.

```c
void UART_Init(UART_Type *pUART, UART_ConfigType *pConfig)
{
    uint16_t u16Sbr, u16Brfa;
    uint8_t u8Temp;
    uint32_t u32SysClk = pConfig->u32SysClkHz;
    uint32_t u32Baud = pConfig->u32Baudrate;

    /* Sanity check */
    ASSERT((pUART == UART0) || (pUART == UART1));

    /* Enable the clock to the selected UART */
    if (pUART == UART0)
    {
    SIM->SCGC4 |= SIM_SCGC4_UART0_MASK;

    if (pUART == UART1)
    {
        SIM->SCGC4 |= SIM_SCGC4_UART1_MASK;
    }

    /* Ensure the transmitter and receiver are disabled when changing settings*/
    pUART->C2 &= ~(UART_C2_TE_MASK | UART_C2_RE_MASK);
    /* Configure the UART for 8-bit mode, no parity */
    pUART->C1 = 0;

    /* Calculate baud settings */
    //u16Sbr = (((u32SysClk) >> 4) + (u32Baud >> 1))/u32Baud;
    u16Sbr = (uint16)((((u32SysClk*1000) >> 4))/u32Baud);
    /* Save off the current value of the UARTx_BDH except for the SBR field */
    u8Temp = pUART->BDH & ~(UART_BDH_SBR_MASK);
    pUART->BDH = u8Temp | UART_BDH_SBR(((u16Sbr & 0x1F00) >> 8));
    pUART->BDL = (uint8_t)(u16Sbr & UART_BDL_SBR_MASK);

    /* Determine if a fractional divider is needed to get closer to the baud rate */
    u16Brfa = (((u32SysClk*32000)/(u32Baud * 16)) - (u16Sbr * 32));
```
The initialization above can be simplified to the following steps:

1. Enable the UART pins by configuring the appropriate PORTx_PCRn registers (not shown in the code example).
2. Enable the clock to the UART module.
3. Disable the transmitter and receiver. This step is included to ensure that the UART is not active when it is being configured. This step is not needed if the uart_init function is always called when the UART is already in a disabled state (the UART is disabled after reset by default).
4. Configure the UART control registers for the desired format. For 8-N-1 operation no UART registers need to be configured (the default register settings configure the UART for 8-N-1 operation).
5. Calculate the baud rate dividers. This includes calculating the 13-bit whole number baud rate divider, the SBR field stored in the UARTx_BDH and UARTx_BDL registers, and the 5-bit fractional baud rate divider, the UARTx_C4[BRFA] field.
6. Enable the transmitter and receiver to start the UART.

**7.3.2 UART receive example**

The function below shows an implementation for a simple polled UART receive function. The parameter passed into this function is the UART channel to receive a character (uartch). The function returns the character that is received.

```c
uint8_t UART_GetChar(UART_Type *pUART)
{
    /* Sanity check */
    ASSERT((pUART == UART0) || (pUART == UART1));

    /* Wait until character has been received */
    while (!(pUART >= S1 & UART_S1_RDRF_MASK));

    /* Return the 8-bit data from the receiver */
    return pUART >= D;
}
```

Because this is a polled implementation, the function will wait until a character is received. If no character is received, then the code will remain in the while loop indefinitely. To avoid code getting stuck when no traffic is being received, include a function to test whether a character is present. The uart_getchar_present function can be called prior to calling the uart_getchar function in cases when UART receive traffic is not guaranteed or required before moving on with program execution.
int UART_GetChar_Present (UART_Type *pUART)
{
    return (pUART ≥ S1 & UART_S1_RDRF_MASK);
}

7.3.3 UART transmit example

This function is an implementation for a simple polled UART transmit function. The parameters passed into this function are the UART channel that will be used to transmit (uartch) and the character to be sent (ch).

void UART_PutChar(UART_Type *pUART, uint8_t u8Char)
{
    /* Wait until space is available in the FIFO */
    while (!(pUART ≥ S1 & UART_S1_TDRE_MASK));

    /* Send the character */
    pUART ≥ D = (uint8_t)u8Char;
}

7.3.4 UART configuration for interrupts or DMA requests

The examples included here poll UART status flags to determine when receive data is available or when transmit data can be written into the FIFO. This approach is the most CPU intensive, but it is often the most practical approach when handling small messages. As message sizes increase it might be useful to use interrupts or the DMA to decrease the CPU loading. However, the overhead required to set up the interrupts or DMA should be taken into account. If the additional overhead outweighs the reduction in CPU loading, then polling is the best approach.

Using the UART interrupts to signal the CPU that data can be read from or written to the UART will help to decrease the CPU loading. The UART has a number of status and error interrupt flags that can be used, but for typical receive and transmit operations the receive data register full flag (UARTx_S1[RDRF]) and transmit data register empty flag (UARTx_S1[TDRE]) would be enabled using the UARTx_C2[TIE, RIE] bits. The names of these flags are a bit misleading, since they don't always indicate a full or empty condition. For UARTs that include a FIFO, the full or empty condition is determined based on the amount of data in the FIFO compared to a programmable watermark. If both the RDRF and TDRE interrupt requests are enabled, then the UART interrupt handler would need to read the S1 register to determine which condition is true then read and/or write to the UART data register (UARTx_D) to clear the flags. Since the CPU is still responsible for moving data there is CPU loading associated with an interrupt-driven software approach.
Using the DMA to move data can help to decrease the CPU loading even more than using the UART interrupts. The UART's same RDRF and TDRE flags used for an interrupt-driven software approach can be re-routed to the eDMA controller instead. This is done by setting the UARTx.C5[TDMAS, RDMAS] bits. Each of these requests would be routed to a different eDMA channel (the specific eDMA channels would be selected by programming the DMA channel mux). One eDMA channel would be responsible for handling receive traffic, so it would read one or more bytes from the UART for each request. The second eDMA channel would be responsible for handling the transmit traffic, so it would write one or more bytes to the UART for each request. When the entire transmit or receive DMA movement is complete the eDMA can interrupt the core to notify it of the completion. In this approach the CPU has no loading associated with the actual data movement. All of the CPU loading is the result of the initial configuration of both the UART and eDMA modules and then any processing of data that is required to prepare it for transmission or interpret it after reception.

7.4 UART RS-232 hardware implementation

This block diagram illustrates the hardware connections for an RS-232 implementation. The diagram shows the optional hardware flow control signals, but only the RX and TX data connections are required.

![Figure 7-1. UART RS-232 hardware connections block diagram](image-url)
Chapter 8
Memory-Mapped Divide and Square Root (MMDVSQ)

8.1 Introduction
The ARM v6M instruction set architecture (ISA) implemented on the Cortex-M0+ core
does not support integer divide instructions or square root functions. However, these
arithmetic operations are widely used in motor control applications. To maximize such
system performance and minimize the device power dissipation, the co-processor
MMDVSQ is included in Kinetis V series to support execution of the integer divide and
unsigned integer square root operations. The supported integer divide operations include
32/32 signed (SDIV) and unsigned (UDIV) calculation.

8.2 Features
The supported features of the MMDVSQ are as follows:

- Lightweight implementation of 32-bit integer divide and square root arithmetic
  operations
  - Supports 32/32 signed and unsigned divide (or remainder) calculations
  - Supports 32-bit unsigned square root calculations
- Simple programming model includes input data and result registers plus a control/
  status register
- Programming model interface optimized for activation from inline code or software
  library call
  - “Fast Start” configuration minimizes the memory-mapped register write
    overhead
  - Supports two methods to determine when result is valid, including software
    polling
  - Configurable divide-by-zero response
8.3  MMDVSQ in Cortex-M0+ core platform

The generic core platform diagram illustrates the location of the MMDVSQ module within the Cortex-M0+ platform.

![Figure 8-1. Generic Cortex-M0+ Core Platform Block Diagram](image)

All functionality associated with the MMDVSQ module resides in the core platform’s clock domain. The MMDVSQ is only clocked when responding to bus requests to its programming model or is busy performing a calculation. This minimizes system power dissipation.

8.4  MMDVSQ programming model

There are four 32-bit memory mapped registers and one status and control register:
• MMDVSQ_DEND (dividend)
• MMDVSQ_DSOR (divisor)
• MMDVSQ_RCND (radicand)
• MMDVSQ_RES (result)
• MMDVSQ_CSR (control/status)

These registers can only be accessed via word-sized (32-bit) accessed. At any instant in time, the MMDVSQ can perform either a divider or square root calculation.

For divide, the specific operation to be performed according to the following table:

**Table 8-1. Determining Divide Specific Operations**

<table>
<thead>
<tr>
<th>MMDVSQ_CSR[REM]</th>
<th>MMDVSQ_CSR[USGN]</th>
<th>Which divide operation to perform?</th>
</tr>
</thead>
<tbody>
<tr>
<td>0</td>
<td>0</td>
<td>Signed divide</td>
</tr>
<tr>
<td></td>
<td></td>
<td>MMDVSQ.RES = quotient (MMDVSQ_DEND/MMDVSQ_DSOR);</td>
</tr>
<tr>
<td>0</td>
<td>1</td>
<td>Unsigned divide</td>
</tr>
<tr>
<td></td>
<td></td>
<td>MMDVSQ.RES = quotient (MMDVSQ_DEND/MMDVSQ_DSOR);</td>
</tr>
<tr>
<td>1</td>
<td>0</td>
<td>Signed divide</td>
</tr>
<tr>
<td></td>
<td></td>
<td>MMDVSQ.RES = remainder (MMDVSQ_DEND%MMDVSQ_DSOR);</td>
</tr>
<tr>
<td>1</td>
<td>1</td>
<td>Unsigned divide</td>
</tr>
<tr>
<td></td>
<td></td>
<td>MMDVSQ.RES = remainder (MMDVSQ_DEND%MMDVSQ_DSOR);</td>
</tr>
</tbody>
</table>

For overflow divide (dividend = 0x80000000, divisor = 0xFFFFFFFF), MMDVSQ exactly follows the ARM Cortex-Mx definition and return 0x80000000 as quotient with no indication of the overflow condition. The remainder is 0 in this case.

For divide-by-zero, the MMDVSQ_CSR[DZ] indicator will be set and the quotient or remainder result is forced to 0. If MMDVSQ_CSR[DZE] = 1, then an attempted read of the result register is error terminated to signal software of a divide-by-zero condition.

For square root, MMDVSQ_RES = integer (MMDVSQ_RCND); the result is limited to 16-bit value with MMDVSQ_RES[31:16]=0x0000.

There is “fast start” or “normal start” of divide operation which is controlled by MMDVSQ_CSR[DFS]. “fast start” means that a write to MMDVSQ_DSOR register starts the divide, whereas “normal start” means that the divide operation is started by setting the MMDVSQ_CSR[SRT] bit. The “fast start” is used by default.

The following code shows how to do signed divide and get quotient in u32Result:

```c
MMDVSQ -> CSR & = ~(MMDVSQ_CSR_REM_MASK | MMDVSQ_CSR_USGN_MASK);
```
The following code shows how to do signed divide and get remainder in u32Result:

```c
MMDVSQ -> CSR = (MMDVSQ >= CSR & ~(MMDVSQ_CSR_USGN_MASK)) | MMDVSQ_CSR_REM_MASK;
MMDVSQ -> DEND = i32Numerator;
MMDVSQ -> DSOR = i32Denominator;
u32Result = MMDVSQ -> RES;
```

The following code shows how to get the square root of u32Data in u16Result:

```c
MMDVSQ -> RCND = u32Data;
u16Result = MMDVSQ -> RES;
```

### 8.5 Square root using Q notation for fractional data

For the unsigned fractional data using u(unsigned)Qm.n notation, it requires \( m+n \) bits \( (m+n = 32) \) for the input radicand. The \( uQm.n \) format produces a \( uQ(m/2).(n/2) \) square root.

For example, \( \pi \) in \( uQ0.2.30 \) format is 0xC90FDAA0. To obtain \( \sqrt{\pi} \), MMDVSQ_RCND = 0xC90FDAA0, and the result of its square root is 0x0000E2DF which is 1.7724304199 when interpreted as \( uQ0.15 \) format. The error of result is -0.001%.

### 8.6 Execution time

The MMDVSQ module includes early termination logic to finish both divide and square root calculations as quickly as possible, based on the magnitude of the input operand. Therefore, the execution time for the calculations is data dependent on MMDVSQ_DEND. The execution time is defined from the register write to initiate the calculation until the result register has been updated and available to read (i.e., time with MMDVSQ_CSR[BUSY]=1).

For both divide and square root operation, the shortest execution time is 1 core cycle, and the longest is 17 cycles. For example, if MMDVSQ_DEND = 0, then the execution time is 1 core cycle; if MMDVSQ_DEND = 01xx xxxx xxxx xxxx xxxx xxxx xxxx xxxx in binary format, then the execution time is 17 core cycles.

For more detail information on the execution time, refer to the reference manual.
8.7 Tips of usage

8.7.1 Tips for minimizing the interrupt latency

A memory read of MMDVSQ_RES register while the calculation is still being performed causes the access to be stalled via the insertion of bus wait states until the new result is loaded into this register. A stalled bus cycle cannot be interrupted. So if system interrupt latency is a concern, a simple wait loop code shall be added to poll MMDVSQ_CRS[BUSY] before reading the result register. Because the polling code is fully interruptible, the interrupt latency is minimized.

8.7.2 Tips for context save and restore in interrupt

If the last calculation was a zero divide and the divide-by-zero enable is set, then a read of the MMDVSQ_RES register is error terminated. To avoid such error termination during a context save, follow the steps below:

1. Read MMDVSQ_DEND, DSOR, and CSR register and save their values
2. Clear MMDVSQ_CSR[DZE] bit
3. Read MMDVSQ_RES register and save its value

When restoring the context, do not initiate another divide calculation by disabling the “fast start” of divide before reloading the MMDVSQ_DEND, DSOR registers. Follow the steps below:

1. Write 0x00000020 to MMDVSQ_CSR to disable the fast start mechanism
2. Reload MMDVSQ_DEND, DSOR, and RES register with their previous saved values
Chapter 9
Analog-to-Digital Converter (ADC)

9.1 Overview

Each sub-family of the Kinetis V series may have a different ADC module. This chapter describes the ADC module used in KV1x sub-family. The ADC module is a SAR type with up to 16-bit resolution. It has two independent ADCs, ADC0 and ADC1. The ADC module supports up to 4 pairs of differential inputs and up to 24 single-ended inputs and features a self-calibration mode, automatic compare, and hardware average. The ADCx (x=0, 1) has two conversion result registers, ADCx_RA and ADCx_RB, and completes 4-channel samples using a trigger event.

9.2 Introduction

The ADC module can be configured to single-end mode or differential mode. The Output is right-justified unsigned format for single-ended modes, and it is 2's complement 16-bit sign extended for differential modes. The single mode has 16-bit, 12-bit, 10-bit and 8-bit. The differential mode includes 16-bit, 13-bit, 11-bit and 9-bit. The MSB is symbol placement, “1” is negative, and “0” is positive.

Each ADC has 12 external channels from ADCx_SE0 to ADC_SE11 in single-end mode, and ADC0 can be configured 2 pair’s differential mode “ADC0_DP0 and ADC0_DM0” and “ADC0_DP1 ADC0_DM1”, and ADC1 can be configured 2 pair’s differential mode “ADC1_DP1 and ADC1_DM1” and “ADC1_DP2 ADC0_DM2”. There is internal temperature sensor, Bandgap, VREFH and VREFL channel, it is convenient to test junction or ambient temperature using integral temperature sensor and it can remove temperature drift error in reference via internal reference channel at any time.

ADC has self-calibration function, the user has to calibrate ADC at beginning of the conversion. Calibration function can remove the offset effectively.
ADC has hardware average function, it can be set to 4, 8, 16 and 32 samples average. Automatic compare function has less-than, greater-than or equal-to, within range, or out-of-range, programmable value.

ADC has low power mode for lower noise application, and long sample selection is good choice for low speed and high accuracy operation. ADC also can be configured to high speed for fast conversion like PMSM motor control application.

ADC has hardware trigger and software trigger mode, ADC can be configured to continuous conversion via only one trigger signal.

ADC supports DMA operations, the conversion flag can trigger DMA transfer when the DMA function is enabled.

### 9.3 Features
- 16-bit resolution maximum.
- Four pairs of differential and 24 single-ended external analog inputs
- Single-ended 16-bit, 12-bit, 10-bit, and 8-bit modes. Differential 16-bit, 13-bit, 11-bit, and 9-bit modes
- Long sample, high speed and low power selection
- Conversion complete/hardware average complete flag and interrupt
- Asynchronous clock source for lower noise operation with option to output the clock
- Hardware or software trigger function
- Automatic compare with interrupt for less-than, greater-than or equal-to, within range, or out-of-range, programmable value
- Temperature sensor
- Hardware average function
- Selectable voltage reference: VREFH/VREFL or VDDA
- Self-Calibration mode
- Transfers of DMA triggers using COCO flag

### 9.4 ADC configuration

An initialization procedure is necessary when the user want to get the valid data from conversion result register, the typical sequence as follows:

1. 1. Enable ADC clock gate.
2. ADC calibration, the user can find the details information of calibration on reference manual 32.4.7 Calibration function.
3. Configure ADCx_CFG1 and ADCx_CFG2. Select input clock source, divider, ADC conversion mode, long sample time configuration. Once configure ADCx_CFG1 register, the user has to update ADCx_CFG2 register according to ADCx_CFG1 configuration.

4. Configure ADCx_SC2 and ADCx_SC3. Select trig mode, compare function and, reference voltage and average function, etc. if compare function is enable, ADCx_CVn register should be correct value.

5. Configure ADCx_SC1n, set up differential or interrupt control bit.

6. Write channel number in ADCx_SC1n. If software trigger is enable, it will kick off ADC conversion.

7. Check COCO conversion complete flag.

8. Read ADCx_Rn.

The hardware trigger is from PDB module, so the user has to configure PDB module if hardware is enable. The ADC configuration should be prior to PDB and peripheral. For example, if the users want to use FTM channel flag to trig ADC, the user needs to configure ADC firstly, secondly configure PDB, FTM is configured at last. It is order to do not neglect the trigger when ADC or PDB is not ready.

9.5 ADC hardware design considerations

There are some tips for ADC sample circuit design on PCB. Analog inputs should also have low pass filters. The challenge with analog inputs, especially for high resolution analog-to-digital conversions, is that the filter design needs to consider the source impedance and sample time rather than a simple cutoff frequency.

This topic cannot be discussed in detail here, but the general concept is that fast sample times will require smaller capacitor values and source impedances than slow sample times. Higher resolution inputs may require smaller capacitor values and source impedances than lower resolution inputs.

In general, capacitor values can range from 10 pF for high speed conversions to 1 uF for low speed conversions. Series resistors can range from a few hundred Ohms to 10 kΩ.

Use the following general routing and placement guidelines when laying out a new design. These guidelines will help to minimize signal quality problems. The ADC validation efforts focused on providing very stable voltage reference planes and ground planes.
• Use high quality RC components for the anti-aliasing filter. Place this RC filter as close to the ADC input pins as possible where it can remove the most noise.
• Provide very stable analog ground and voltage planes, both for analog power and voltage references if full accuracy of the ADC is required.

**Note**
When building an external voltage divider on the ADC input pin to sample high voltage, choose the voltage divider with the lowest equivalent resistor value, because the ADC input resistance is only 5K Ω.
Chapter 10
Programmable Delay Block (PDB)

10.1 Overview

The Programmable Delay Block (PDB) is interconnected with the ADC, CMP, and FTM. The PDB has a pre-trigger function for ADC and provides an interval interrupt as a 12-bit DAC hardware trigger. Individual PDB pulse-out signals are connected to each CMP block and used for the sample window. The PDB channel 1 pre-trigger can also be used as an FTM synchronous input.

10.2 Introduction

The PDB provides the programmable delay time for trigger input source, the PDB interval trigger provides the hardware trigger for 12-bit DAC, and the PDB pulse out for CMP module. The PDB has pre-trigger and back-to-back operations. When pre-trigger is not enabled, the PDB works under bypass mode.

There are two channels in the PDB. Each channel is associated with one ADC, for example, channel 0 is assigned to ADC0, and channel 1 is assigned to ADC1. The PDB can be configured to pre-trigger mode and bypass mode. One PDB channel can be configured as two pre-triggers, pre-trigger0 and pre-trigger1, when the input trigger event is coming, the PDB starts to run, when the PDB counter (the value in PCBx_CNT) matches the channel delay (the value in PDB_CHnDLY0 or PDB_CHnDLY1), the channel flag will be set, and the trigger can be used as ADC hardware trigger. If the pre-trigger is disabled, it works in bypass mode, the input trigger source of PDB can be connected to ADC directly.

The PDB pre-trigger back-to-back mode configures the PDB pre-triggers as a single chain or several chains. PDB back-to-back operation acknowledgment connections are implemented as follows:

- PDB channel 0 pre-trigger 0 acknowledgement input: ADC1SC1B_COCO
- PDB channel 0 pre-trigger1 acknowledgement input: ADC0SC1A_COCO
- PDB channel 1 pre-trigger0 acknowledgement input: ADC0SC1B_COCO
- PDB channel 1 pre-trigger1 acknowledgement input: ADC1SC1A_COCO

DAC interval trigger can from external hardware trigger: ADC0_SC1A[COCO] flag, or DAC interval trigger, the 16-bit interval time can be set in PDBx_DACINTn[INT]. The interval trigger is available once the DAC interval counter matches PDBx_DACINTn[INT] value.

10.3 Features

The programmable delay block features the following:

- Input hardware trigger sources and one of software trigger source, the user can find PDB input trigger source from chip configuration on KV10 reference manual.
- KV10 has two configurable PDB channels for each ADC.
- One PDB channel is associated with one ADC, one trigger output for ADC hardware trigger and has two pre-trigger outputs for ADC trigger select per PDB channel.
- 16-bit delay register per pre-trigger output Trigger outputs, it can be enabled or disabled independently, and it also support bypass of the delay registers of the pre-trigger outputs, the input trigger event is served to ADC directly.
- PDB can works under One-Shot or Continuous modes.
- Optional back-to-back mode operation, which enables the ADC conversions complete to trigger the next PDB channel, there are channel delay interrupt and channel sequence error interrupt and its flag.
- One 16-bit resolution interval trigger output per DAC, optional bypass of the delay interval trigger registers, DAC also has external trigger from ADC0_SC1A[COCO].
- 2 channel pulse outputs for CMP0 and CMP1. Pulse-out's can be enabled or disabled independently, and the pulse width is programmable via PDBx_POnDLY register.
- DMA support.

10.4 PDB pre-trigger

Each PDB channel can produce two pre-trigger outputs, pre-trigger0 and pre-trigger1. The PDB clock source is the bus clock. The pre-trigger delay time (bus clock cycles) is calculated using one of the following:

Pre-trigger0 delay time:
PDBx_SC[PRESCALER] * PDBx_SC[MULT] * PDBx_CHnDLY0 + 2 bus clock cycles. Furthermore, add one additional bus clock cycle to determine the time at which the channel trigger output change.

Pre-trigger1 delay time:

PDBx_SC[PRESCALER] * PDBx_SC[MULT] * PDBx_CHnDLY1 + 2 bus clock cycles. Furthermore, add one additional bus clock cycle to determine the time at which the channel trigger output change.

The pre-trigger delay time must be set carefully. The delay time setup primarily depends on the ADC conversion time.

**Back-to-back function**

The back-to-back mode function can be set in the PDBx_CHnC1[BB] bits which configures the PDB pre-triggers as a single chain or several chains. The PDB back-to-back operation acknowledgment connections signal are from the ADC COCO flag:

- PDB channel 0 pre-trigger 0 acknowledgement input: ADC1SC1B_COCO
- PDB channel 0 pre-trigger1 acknowledgement input: ADC0SC1A_COCO
- PDB channel 1 pre-trigger0 acknowledgement input: ADC0SC1B_COCO
- PDB channel 1 pre-trigger1 acknowledgement input: ADC1SC1A_COCO

![Figure 10-1. Back-to-back mode](image)

PDBx_CHnC1[BB] bits is the back-to-back mode control bit, when PDBx_CHnC1[BB] bit is set to 1; the pre-trigger is produced by the COCO flag. For example, PDBx_CH0C1[BB] =0x02, that’s to say, channel 0 pre-trigger1 is set to 1, this pre-trigger should be produced by ADC0_SC1A COCO flag. When PDBx_CHnC1[BB] bit is set to 0, the corresponding pre-trigger is produced by the channel delay trigger, CHnDLY0 or CHnDLY1.

When all the corresponding back-to-back operations are enabled, all of the pre-trigger output is produced by ADC COCO flag, which creates a closed loop, and the trigger input invalid. The user must begin one of the ADC conversions to produce the COCO flag.
10.5 Ping-Pong operation

10.5.1 PDB pre-trigger sample mode

The user can implement an ADC ping-pong operation with the PDB module. The PDB has a single pre-trigger mode and a back-to-back mode.

The user can only use the pre-trigger out signal to realize a ping-pong operation. For example, there are two channel input signals, the user can choose PDB channel 0 or channel 1. Two pre-trigger signals are sufficient because of the PDB channel delay time, CHnDLY0 and CHnDLY1, and also because enable of the channel pre-trigger and its output. The ping-pong operation will be finished by PDB pre-trigger output source.

Likewise, a 4-channel input signal sample can be finished by ADC0 and ADC1 via PDB channel 0 and channel 1. The PDB module in KV10 can produce a total of four pre-trigger output signals.

![Figure 10-2. 2-Channel ADC Pre-Trigger Sample](image)

10.5.2 Back-to-back sample mode

Back-to-back mode is a useful function similar to ADC high-speed conversion—that is, the pre-trigger output is produced by ADC acknowledgement. You must set the pre-trigger delay time correctly according to the ADC conversion speed, however, back-to-back mode is very compact, therefore decreasing unnecessary pre-trigger delay time.
For example, there are two channel input signals. You can choose between PDB channel 0 or channel 1. To begin, set the channel delay time, CHnDLY0, and then enable the channel pre-trigger and its output. The ping-pong operation will be completed by the PDB pre-trigger output source.

### 10.5.2.1 2-channel ADC input back-to-back sample mode

The next figure provides a sample of the 2-channel ADC back-to-back timing.

![2-channel ADC back-to-back sample](image)

**Figure 10-3. 2-channel ADC back-to-back sample**

### 10.5.2.2 4-channel ADC input pre-trigger sample mode

A 4-channel ADC input can be sampled by one input trigger. To begin, the input trigger starts the PDB and the PDB channel 0 produces pre-trigger0. When CH0DLY0 matches the PDB counter, then ADC0_SC1A begins the ADC conversion; ADC0_SC1A COCO triggers ADC0_SC1B; ADC0_SC1B COCO triggers ADC1_SC1A; ADC1_SC1A COCO triggers ADC1_SC1B. When ADC1_SC1B conversion ends, the new input trigger begins the next 4-channel ADC conversion.
Figure 10-4. 4-channel ADC back-to-back sample
Chapter 11
Using FlexTimer (FTM) via Programmable Delay Block (PDB) to Schedule ADC Conversion

11.1 Overview
This chapter demonstrates how to use the PDB module to schedule and perform ADC conversions via FTM period trigger input, the ADCs work under 16-bit single-end mode, ADC0 samples the voltage on the ADC0_SE1(PTE16), and channel ADC0_SE5(PTE17), and ADC1 samples the voltage ADC1_SE1(PTE18) and ADC1_SE7(PTE18) on TWR-KV10Z32 board. And print the buffered 256 set conversion result via CDC virtual serial port of OpenSDA.

The code example shows how to:

- Make a low-level driver for the ADC, PDB and FTM
- Show how to calibrate the ADC before ADC conversion
- Configure the ADC for averaging a single-ended voltage conversion
- Schedule ADC conversions with the PDB via FTM channel interrupt

11.2 Introduction
Timing of ADC conversions relative to system events is a key to applications, such as motor control, and metering, requiring timing of ADC conversions for the best time to get a noise-reduced reading. When the Kinetis V MCU is acting as a controller, it will output control changes from time to time. Scheduling ADC conversions around these changes, which may make transient disturbances in the system, is key. Scheduling the ADC conversions at a time after the transient effects of the last control change has been made can enable smooth operation of control loops. The PDB allows simple scheduling of one or both of the ADC peripherals conversions. In this example, both ADC’s will be scheduled.
11.3 Features

The ADC features demonstrated by the PWM_PDB_ADC_Lab example code include:

- Simple calibration of the ADC:
  
  A simple driver for the ADC, which facilitates using both ADCs and their calibration with minimal software, is included in the adc_demo example code. Prior to taking the first measurement, during the initialization of the demo project the ADC will be calibrated. The use of the driver of the ADC will simplify this. While the ADC can be used prior to calibration for conversions, the calibration of the ADC enables it to meet its specifications.

- Averaging by 1, 4, 8, 16, or 32:
  
  The ADC’s ability to average up to thirty-two conversion values prior to ending the conversion process and generating a result will be demonstrated. This feature reduces CPU load; it also reduces the effect of a noise spike on any readings. It is a simple arithmetic averaging of thirty-two (or less if so configured) ADC conversions. These conversions are taken upon the PDB triggering the ADC.

- The ADC’s interrupts:
  
  The interrupt feature of the ADC is also used in the example. The ADC conversion result is read from ADCx_Rn registers in the Interrupt Service of ADC0 and ADC1.

- Hardware triggering of the ADC with the FTM via PDB:
  
  The ADC works with the FTM to trigger the ADC’s conversions. Determining which ADC trigger to convert is based on your configuration choices. In this case the ADC will be configured to be triggered only by the FTM channel flag via PDB. The pre-trigger works under back-to-back mode.

- 16-bit resolution:
  
  The conversion results in this example are 16 bit unsigned.

- Differential or single-ended:
  
  Single-ended mode is illustrated in this example.
11.4 Configuration code

In this case the ADCs are configured with four channels in ping-pong fashion triggered by the back-to-back mode of the PDB. The input trigger source is from the periodic FTM channel flag. ADC inputs are not connected to anything of interest for this demo. ADC0_SE1(PTE16) pin is written to ADC0_SC1A[ADCH] and channel ADC0_SE5(PTE17) pin is written to ADC0_SC1B[ADCH]. ADC1_SE1(PTE18) pin is filled in ADC1_SC1A[ADCH] and ADC1_SE7(PTE19) pin is filled in ADC1_SC1B[ADCH].

11.4.1 FTM trigger 4-channel ADC ping-pong conversion via back-to-back mode of PDB

There are several steps taken in the course of the execution of this demo, involving setting up the peripherals. These steps are further detailed with code from the PWM_PDB_ADC_Lab project and explained in the sections that follow, numbered after the manner of the steps:

1. ADC calibration.
2. ADC initialization. Configure ADC clock source and set ADC clock to 18.75MHz, select ADC 12-bit single mode, enable ADC interrupt, and setup ADC ISR. Write 4 channel ADC external input to ADC0 and ADC1.
3. Configure PDB module, configure PDB trigger source and write pre-trigger delay time. PDB works under back-to-back mode, only channel 0 pre-trigger 0 is produced by CH0DLY0 register. The rest pre-triggers are produced by ADC conversion COCO flag.
4. Configure the FTM, set FTM0 Combine mode, and set duty cycle, dead time. Enable FTM clock. Select FTM0 Channel 0 flag as FTM0 trigger source, then enable FTM clock source and start FTM.
5. When FTM0 channel0 flag is set, it is PDB input trigger, and PDB start to run, when PDB channel 0 pre-trigger 0 is set, it trigger ADC conversion, the COCO flag trigger ADC0_SC1B, ADC1_SC1A and ADC1_SC1B conversion one by one.
6. When the 4-channel ADC conversion ends, the ADC will be triggered by next input trigger of FTM0.
7. The ADC conversion result is read in ADC ISR, if 256 set ADC conversion result is available, MCU will send them via serial port.
11.4.2 ADC configuration

The code provided here enables ADC configuration.

```
SIM->CLKDIV1 |= SIM_CLKDIV1_OUTDIV5EN_MASK | SIM_CLKDIV1_OUTDIV5(0x03);
/*!<out5 divider is 4, clock source is 75/4MHz*/
pADC_Config->bClocklSelect = 0x02; /*!<<clock source is alternative clock*/
pADC_Config->bConversionMode = 0x01; /*!<<12-bit single-end mode*/
pADC_Config->bHardwareTriggerEn = TRUE; /*!<<enable ADC hardware trigger*/
pADC_Config->bIntEn = TRUE; /*!<<ADC0 and ADC1 interrupt enable*/
ADC_Cal(ADC0); /*!<<ADC0 calibration*/
ADC_Cal(ADC1); /*!<<ADC0 calibration*/
pADC_Init(ADC0, pADC_Config); /*!<<initial ADC0*/
pADC_Init(ADC1, pADC_Config); /*!<<initial ADC1*/
ADC_SetCallBack(0, ADC0_Task);
ADC_SetCallBack(1, ADC1_Task);

/* write ADC0 channel and ADC1 channel */
ADC0->SC1[0] = (ADC0->SC1[0] & (~0x1F)) | 0x01; /*!<<write ADC0 channel 1*/
ADC0->SC1[1] = (ADC0->SC1[1] & (~0x1F)) | 0x05; /*!<<write ADC0 channel 5*/
ADC1->SC1[0] = (ADC1->SC1[0] & (~0x1F)) | 0x01; /*!<<write ADC1 channel 1*/
ADC1->SC1[1] = (ADC1->SC1[1] & (~0x1F)) | 0x07; /*!<<write ADC1 channel 7*/
```

11.4.3 PDB configuration

The following code shows how to configure the PDB.

```
/* PDB module configuration */
pPDB_Config->bPDBEn = TRUE; /*!<<enable PDB*/
pPDB_Config->u16ModulusValue = 1500; /*!<<set modulo value*/
pPDB_Config->u16InterruptDelay = 1500; /*!<<set interrupt delay value, it is not necessary if disable interrupt*/
pPDB_Config->u16Ch0Delay0 = 200; /*!<<set channel 0 pretrigger 0 delay time*/
pPDB_Config->u16Ch0Delay1 = 1000; /*!<<set channel 0 pretrigger 1 delay time*/
pPDB_Config->u16Ch1Delay0 = 200; /*!<<set channel 1 pretrigger 0 delay time*/
pPDB_Config->u16Ch1Delay1 = 1000; /*!<<set channel 1 pretrigger 1 delay*/
pPDB_Config->u8Ch0PretriggerEn = 0x02; /*!<<enable channel 0 pretrigger 0*/
pPDB_Config->u8Ch0PretriggerOut = 0x03; /*!<<enable channel 0 pretrigger output*/
pPDB_Config->u8Ch1PretriggerOut = 0x03; /*!<<enable channel 1 pretrigger output*/
pPDB_Config->bTriggerSource = 0x08; /*!<<trigger source is from FTM0*/
PDB_Init(pPDB_Config); /*!<<initial PDB module */
```

11.4.4 FTM configuration

The following code demonstrates how to configure the FTM.

```
/* FTM module configuration */
FTM_PinConfig(); /*!<<FTM ouput pin configuration*/
FTM_PWMInit(FTM0, FTM_PWMMODE_COMBINE, FTM_PWM_LOWTRUEPULSE); /*!<<initial FTM to combine */
```
11.4.5 ADC ISR

The following code shows the ADC interrupt service routine which reads ADC results into buffers.

```c
void ADC0_Task(void)
{
    if((ADC0->SC1[0] & ADC_SC1_COCO_MASK)==ADC_SC1_COCO_MASK)
    {
        u8Result0A[u8CycleTimes] = ADC0->R[0];
        PTD->PTOR = (1<<7);
    }
    if((ADC0->SC1[1] & ADC_SC1_COCO_MASK)==ADC_SC1_COCO_MASK)
    {
        u8Result0B[u8CycleTimes] = ADC0->R[1];
        PTD->PTOR = (1<<6);
    }
}
```

The code for the ADC ISR includes the following functions:

- **FTM_SetModValue(FTM0, 4678);**
  - Set the FTM period to 16KHz, the modulo value is equal to (75000/16) - 1.
- **FTM_PWMDeadtimeSet(FTM0, 2, 0x13);**
  - Set channel n-1 dead time, 1us.
- **FTM_ClockSet(FTM0, FTM_CLOCK_SYSTEMCLOCK, FTM_CLOCK_PS_DIV1);**
  - Set clock source and start the counter.
- **FTM_SetDutyCycleCombine(FTM0, FTM_CHANNEL_CHANNEL1, 50);**
  - Set the duty cycle, note: only fit for combine mode.
- **FTM0->EXTTRIG = 0x10;**
  - Trigger source is from FTM0 channel 0 trigger.
- **The while loop reads ADC conversion results.**
  - Wait for u8Result0A[i], u8Result0B[i], u8Result1A[i] and u8Result1B[i] to be full.
  - Print the ADC conversion results.
  - Echos characters received from the terminal.

**Pass/Fail criteria:**

- None

---

**Kinetis V Series Peripheral Module Quick Reference, Rev. 0, 02/2014**

Freescale Semiconductor, Inc. 89
@param none
*
* @return none
* @ Pass/ Fail criteria: none
*****************************************************************************/

void ADC1_Task(void)
{
    if((ADC1->SC1[0] & ADC_SC1_COCO_MASK)==ADC_SC1_COCO_MASK)
    {
        u8Result1A[u8CycleTimes] = ADC1->R[0];
    }
    if((ADC1->SC1[1] & ADC_SC1_COCO_MASK)==ADC_SC1_COCO_MASK)
    {
        u8Result1B[u8CycleTimes] = ADC1->R[1];
        u8CycleTimes++;
    }
}
Chapter 12
FlexTimer Module (FTM)

12.1 Overview
This chapter will demonstrate the features of the FlexTimer Module (FTM) of Kinetis V series devices. It also presents examples of how to properly configure the module to achieve its required operational mode. One of the examples included in this chapter utilizes two different modes of FTM operation: input capture and PWM mode. Another example mentions the PWM functionality of FTM working in very low power stop mode (VLPS).

12.2 Introduction
The FTM is built on the base of TPM module well known from Freescale 8-bit microcontrollers. The FTM extends the functionality to meet the demands of motor control, digital lighting solutions, and power conversion, while providing low cost and backwards compatibility with the TPM module.

12.3 Features
The features of FTM on all Kinetis V series devices can vary in the number of FTMs and the channels included in each module. The FTM functionality can be summarized into six basic modes of operation:

- Input capture
- Output compare
- PWM
- Deadtime insertion
- Quadrature decoder
- Fault control
The timer can also operate as a free running 16-bits counter.

### 12.3.1 FTM clock

The FTM source clock is selectable:

- System clock
- Fixed frequency clock
- External clock

Source clock can be the system clock, the fixed frequency clock, or an external clock. Fixed frequency clock is an additional clock input to allow the selection of an on-chip clock source other than the system clock. Selecting external clock connects FTM clock to a chip level input pin therefore allowing to synchronize the FTM counter with an off chip clock source.

The prescaler divide-by 1, 2, 4, 8, 16, 32, 64, or 128.

### 12.3.2 Interrupts and DMA

FTM supports three types of interrupt:

- Timer overflow interrupt
- Channel (n) interrupt
- Fault interrupt

The channel generates a DMA transfer request according to DMA and CHnIE bits.

### 12.3.3 Modes of operation

If no mode is selected by MSBx bits in channel status and control register, the counter is fully operational but there is no pin control. Therefore edge/level sensitivity selection by ELSx bits does not play any role.

In an input capture mode, rising, falling, or both edges can be captured. Considering some restrictions, it allows this module to measure, for example, pulse width or time period of input signal. Captured edge values can be read from FTMx_CnV. Any writes to this register are ignored in input capture mode. For some selected FTM channels, comparator output can also be used for capturing.
In an output compare mode, set, clear, or toggle of output on match can be achieved. This mode also allows the generation of positive or negative pulses on the match event. This event occurs on compare match of FTMx_CNT and FTMx_CnV.

The most useful feature of the FTM is pulse width modulation (PWM). Edge- (up counting) and center- (up-down counting) aligned PWM are available in this timer module via FTMx_SC[CPWMS]. Both modes of operation provide positive (high true) or negative (low true) PWM pulse generation. The channel pulse width is a proportional part of modulo value and is defined by FTMx_CnV. Combine mode is not available in this module.

### 12.3.4 Updating MOD and CnV

Any writes to FTMx_MOD or FTMx_CnV latch the value into an equivalent register buffer. The register is updated by its buffer value depending on clock mode selection:

- When the FTM is disabled by CMOD then MOD or CnV registers are updated immediately after they are written.
- When the FTM is enabled by CMOD and selected mode is output compare the CnV register is updated on the next counter increment immediately after CnV register was written.
- In every other case the MOD and CnV registers are updated immediately after the FTM counter reaches the MOD value.

### 12.3.5 FTM period

The FTM time period is based on the period of the FTM source clock, prescaler value, modulo value, and also depends on alignment in the case of PWM mode. Therefore, the period of FTM can be calculated as:

$$\text{FTM period} = \frac{\text{prescaler value}}{\text{FTMx_MOD} \times \text{CLKsourceperiod} \times \text{FTMx_SC[CPWMS]}}$$

**Equation 1. FTM period calculation**

For example, when:

- The system clock = 48 MHz is selected as a source clock for counter. The CLKS[1:0] bits in the SC register are 01
- Prescaler factor is selected to divide source clock by 16 (FTMx_SC_PS = 0x4)
- The FTM modulo value is set to 3000 (FTMx_MOD = 0x0BB8) and edge aligned mode is selected
12.3.6 Additional features

The global time base feature can be used for the synchronization of all modules. In this case, all modules use the same time base. Only one FlexTimer module is used as global time, as detailed in the device reference manual.

FTM continues to function in debug mode. The behavior of FTM in debug mode is configured by FTMx_CONF.BDMMODE[1:0].

12.4 Configuration examples

Two basic examples of FTM configuration will be demonstrated in this section. The first example uses edge-aligned PWM and the second example shows input capture features of FTM working in normal run mode.

NOTE

In these examples, TWR-KV10Z32 with PKV10Z32 is used. Optionally, TWR-PROTO, TWR-ELEV, and TWR-SER can be used.

12.4.1 Example – Edge Aligned PWM and Input Capture Mode

This example demonstrates the basic features of the FTM, such as input capture and edge-aligned PWM mode. In this case, FTM0 is configured to work in edge-aligned PWM mode. This module uses two channels: channel 1 and channel 2.

Channel 1 is configured to generate positive PWM pulses. Channel 2 is configured to generate negative PWM pulses (inverse PWM). Module FTM1 is configured to work in input capture mode. Channel 0 is configured to capture rising edges and in contrast channel 1 is configured to capture falling edges. The purpose of this configuration is to be able to measure, for example, the pulse width of the pulses generated by FTM0. This can be achieved by interconnecting channel 1 of FTM0 and both channels of FTM1, as shown in the following figure.

\[
\text{FTM period} = \frac{16}{48000000 \times (7/0)} \times 1 = 1\text{ms}
\]

\[
\text{FTM frequency} = \frac{1}{\text{FTM period}} = \frac{1}{0.001} = 1\text{kHz}
\]

Equation 2. FTM period calculation example
Before configuring both FTM modules, SIM must configure all required clock options. In this example, system clock is used as a source clock for FTM. Therefore, it is necessary to set FTMx_SC.CLKS[1:0] to 1. Next, the clocks for the ports whose pins will be used must also be enabled. In this example, pin PTC2 and PTC3 are used as channel outputs of FTM0, and PTD6 and PTD7 are used as channel inputs of FTM1. Therefore, clocks for PORTC must be enabled. In the end, the clock gates must be enabled for both of the FTM modules used. Follow the next few lines of code with required SIM module configuration.

```c
/* Enable PORTC/D clocks */
SIM->SCGC5 |= SIM_SCGC5_PORTC_MASK | (SIM_SCGC5_PORTD_MASK;
/* Enable FTM0/1 clocks */
SIM->SCGC6 |= SIM_SCGC6_FTM0_MASK;
SIM->SCGC6 |= SIM_SCGC6_FTM1_MASK;
```

**NOTE**

If any additional clock settings are required in your application, they must also be implemented in SIM configuration.

After SIM initialization, required port pins must be configured according to their use. It is necessary to clear only interrupt status flag, select an alternative pin for the FTM channel, and for outputs you can enable drive strength.

```c
/* Enable the FTM0 Ch1/2 function on PTC2/3 */
PORTC->PCR[2] = PORT_PCR_MUX(0x4);
PORTC->PCR[3] = PORT_PCR_MUX(0x4);
/* Enable the FTM1 Ch0/1 function on PTD6/7*/
PORTD->PCR[6] = PORT_PCR_MUX(0x5);
PORTD->PCR[7] = PORT_PCR_MUX(0x5);
```

The next step is the configuration of FlexTime modules. FTM0 configuration is demonstrated first. In this module, timer overflow interrupt will be enabled. Therefore, NVIC must be set before module interrupt is enabled.

```c
/* enable FTM2 interrupt in NVIC */
NVIC_EnableIRQ(FTM0_IRQn);
```

You can also redefine interrupt vector to your interrupt service routine. This must be done in a different module, such as isr.h.

```c
extern void FTM0_Isr(void);
#undef VECTOR_033
#define VECTOR_033 FTM0_Isr
```
Then FTM0 module can be initialized. FTM0_CONF should stay in its default state. For best performance, initialize the counter, that is, write to FTM0_CNT, before writing to the modulo register. Modulo value MOD is set to 4800 to generate a PWM signal with 10 kHz, assuming that the system clock is set to 48 MHz. Then FTM0_SC will enable timer overflow interrupt, set edge-aligned (up counting) mode, select clock mode to allow the counter to increment on every clock, and set the prescaler divider to 1.

```c
/* update MOD value */
FTM_SetModValue(FTM0, 4800);
/* set clock source, start counter */
FTM_ClockSet(FTM0, FTM_CLOCK_SYSTEMCLOCK, FTM_CLOCK_PS_DIV1);
```

Channels configuration must be done after general FTM0 module configuration. Channel 1 of FTM0 is configured as edge-aligned PWM with high-true pulses (positive PWM pulses). Channel 2 is configured as edge-aligned PWM with low-true pulses (negative pulses). Channel interrupt is disabled. Channels value must also be initialized.

```c
pFTM->CONTROLS[1].CnSC = FTM_CnSC_MSB_MASK | FTM_CnSC_ELSB_MASK;
pFTM->CONTROLS[1].CnV  = 0;
pFTM->CONTROLS[2].CnSC = FTM_CnSC_MSB_MASK | FTM_CnSC_ELSA_MASK;
pFTM->CONTROLS[2].CnV  = 0;
```

**NOTE**

Both channels of the FTM are configured in inverse PWM to demonstrate how one leg of the three phase converter used in motor control application can be configured. Also note that dead time control is available in the Kinetis V series FTM.

This module generates interrupt on timer overflow. It is convenient to clear the corresponding flag in interrupt service routine. Value register is also set.

```c
void FTM0_Isr(void)
{
    /* clear the flag */
    FTM_ClrOverFlowFlag(FTM0);

    /* update the channel value */
    FTM_SetChannelValue(FTM0, FTM_CHANNEL_CHANNEL1, u16ChV_new);
}
```

**NOTE**

Setting the compare value in the timer overflow interrupt service routine of the same FTM is not a best practice. CnV registers are updated by their buffer value immediately after timer overflow. Therefore, one period of FTM can be lost in such a case. Instead, set compare value immediately before timer overflow.
After FTM0 initialization, FTM1 should be initialized. As mentioned previously, this module is configured to work in input capture mode. This module is also configured to generate interrupt on timer overflow. It is then required to enable vector interrupt for this module and set priority as in previous FTM configuration.

```c
NVIC_EnableIRQ(FTM1_IRQn);
```

In `isr.h`, redefine interrupt vector.

```c
extern void FTM1_Isr(void);
#undef VECTOR_034
#define VECTOR_034      FTM1_Isr
```

Because pulse width measurement uses FTM1, it is desirable to trigger start of FTM1 counting by FTP0 overflow. Therefore, FTM0_CONF sets input trigger to TMP0 overflow and enables counter start on trigger. For more information, see Figure 13-2. Counter is set to stop on overflow and input trigger provides its restart. The rest of the configuration is similar to FTM0, except modulo value, which can be set higher. In this example, it was set to 11200, assuming FTM1 period is 4285 Hz.

```c
FTM_ClockSet(FTM1, FTM_CLOCK_SYSTEMCLOCK, FTM_CLOCK_PS_DIV1);
FTM_EnableChannelInt(FTM1, 1);
```

Channels of FTM1 are configured to input capture mode. Channel 0 is configured to capture rising edges and channel 1 is configured to capture falling edges. There is no interrupt on the generated channel event.

```c
/* configure FTM1_CH0 and FTM1_CH1 to measure the input wave pulse width */
FTM_DualEdgeCaptureInit(  FTM1, FTM_CHANNELPAIR0,
FTM_INPUTCAPTURE_DUALEDGE_ONESHOT,
FTM_INPUTCAPTURE_DUALEDGE_RISINGEDGE,
FTM_INPUTCAPTURE_DUALEDGE_FALLINGEDGE );
```

FTM1 also generates interrupt on time overflow. In the interrupt service routine, the timer overflow flag is cleared and pulse width is calculated from the rising and falling edges values of channels. Channel flags must also be cleared in to be able to capture edges in the next FTM1 period.

```c
void FTM1_Isr(void)
{
    FTM_ClrChannelFlag(FTM0, FTM_CHANNELPAIR0);
    FTM_ClrChannelFlag(FTM0, FTM_CHANNELPAIR0+1);
    u8IntMark = 1;
}
```

**NOTE**

When a different input signal will supply FTM1 inputs, then it is recommended to increase modulo value to 65535 to reach the highest possible resolution of pulse width measurement. Also note that if the result of pulse width is negative, it should not be taken into account. In this case, rising edge (FTM1_C0V) was captured two periods before and falling edge (FTM1_C1V) was captured two periods after the event.
captured only in the previous period. Therefore, the result is incorrect.

Figure 12-2. Functional description of example (RE – rising edge, FE – falling edge, CSOO – counter stop on overflow, CSOT – counter start on trigger)
Appendix A
How to Load QRUG Examples

A.1 Overview
This chapter describes how to load and run the sample code described in other sections of the Kinetis V series Quick Reference User Guide. It describes the procedures used to ensure your Tower system or Freedom board is connected properly, and explains how to load the example projects.

A.2 Software configuration
For compiling, flash downloading, and debug functioning, you will need to install IAR System's Embedded Workbench for ARM (EWARM) V6.70.3 or later, as well as any patches and updates available at www.iar.com. EWARM supports Open SDA, the firmware located on your Kinetis V series Tower board that enables you to flash and debug code with only a mini-B USB cable.

The projects you will be working with can be found on the Freescale website: www.freescale.com

Using the EWARM and installing and downloading the project files to the Kinetis V series Tower board will enable you to use the OPEN SDA interface.

A.3 Hardware configuration
The examples can be run with the Kinetis V series microcontroller module in stand-alone mode. Alternatively, you can put together your Tower kit for examples using serial a channel interface without using the Open SDA serial channel.

Connect a USB cable to the mini-USB port on the Kinetis V series board. This will be:

- J23 on TWR_KV10Z32
When you plug in the USB cable to your board, you will see LEDs on the board turn on.

### A.4 Terminal configuration

The OPEN SDA feature on the Kinetis V series Tower board will create a serial port that communicates to your computer over the USB cable, which was connected in the previous section. This virtual serial port is connected to UART0 on the TWR-KV10Z.

To configure the terminal:

1. Open your computers device manager and look in the COM Ports and read what COM port number is assigned to the OPEN SDA port.
2. Open the Terminal Utility.
3. Configure the terminal client to use indicated COM port, 115200 baud, 8 data bits, 1 stop bit, and no parity.
4. Then open the Serial Port to start the connection.

### A.5 Download sample code

To download sample code:

1. Save locally the latest sample code for your Tower module from:
2. Run the install and save into any directory.
3. Go to kvxx-driv-lib\build\iar\ to see all of the different projects available.
4. The next section describes running the basic low power demo example, but the same instructions can also be used with other projects.

### A.6 Running the "Blinky_green" project

To run this project:

1. Open IAR and go to File -> Open -> Workspace in the menu bar.
2. Open the Blinky_green workspace at kvxx-driv-lib\build\iar\kv10\Blinky_green\. 
3. The workspace that opens contains a “Blink_green” project for the TWR-KV10Z.
4. There are two flash combinations available in the demo which this project supports; FLASH_32KB and FLASH_16KB. Select FLASH_32KB for the TWR_KV10 board.
5. The selected project will appear in bold font.
6. To ensure a fresh start, clean the project by right-clicking on the project name and selecting Clean.
7. Compile the project by clicking the Make icon, or right-click on the project and select Make.
8. In the build dialog box at the bottom, you will see any errors or warnings. If the compilation was successful and there are no errors, you will see something like the image below. There may be some warnings depending on the code:

```c
#include "system_MKV1027.h"
#include "MKV1027.h"
#include "kv10_config.h"
#include "DLib_Config_Normal.h"
#include "isr.h"

int main (void);
void LPTMR_Init(int count, int clock_source);
void LPTMR_Isr(void);

/* Global functions*/

int main (void)
{
    uint8_t u8Ch;
    printf("\nRunning the Blinky_green project.\n");

    LED0_Init();
    LED2_Init();
    LED4_Init();

    /*select LPO as LPTMR clock source */
    LPTMR_Init(1000,1);

    printf("Please enter any character which will echo\n");
}
```

Total number of errors: 0
Total number of warnings: 3
9. Download the code to the board and start the debugger by pressing the Download and Debug button.
10. The code will download into flash. The debugger screen will appear and pause at the first instruction. Click the Go button to start running.

11. After you select Go, the software will print out information and indicate to input any character which will echo, meanwhile the green LED (D1,D3,D5) begins to blink.

Running the Blinky_green project.
Please enter any character which will echo...
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